



# THE DATASHEET OF DS90UR916QSQX/NOPB

## DS90UR916Q 5 - 65 MHz 24-bit Color FPD-Link II Deserializer with Image Enhancement

Check for Samples: [DS90UR916Q](#)

### FEATURES

- 5 – 65 MHz PCLK support (140 Mbps – 1.82 Gbps)
- RGB888 + VS, HS, DE Support
- Image Enhancement - White Balance LUTs and Adaptive Hi-FRC Dithering
- AC Coupled STP Interconnect Cable up to 10 Meters
- @ Speed Link BIST Mode and Reporting Pin
- I2C Compatible Serial Control Bus
- Power Down Mode Minimizes Power Dissipation
- 1.8V or 3.3V Compatible LVCMOS I/O Interface
- Automotive Grade Product: AEC-Q100 Grade 2 Qualified
- >8 kV HBM and ISO 10605 ESD Rating
- FAST Random Ddata Lock; No Reference Clock Required
- Adjustable Input Receiver Equalization
- LOCK (Real Time Link Status) Reporting Pin
- EMI Minimization on Output Parallel Bus (SSCG)
- Output Slew Control (OS)
- Backward Compatible Mode for Operation with Older Generation Devices

### APPLICATIONS

- Automotive Display for Navigation
- Automotive Display for Entertainment

### DESCRIPTION

The DS90UR916Q FPD-Link II deserializer operates with the DS90UR905Q FPD-Link II serializer to deliver 24-bit digital video data over a single differential pair. The DS90UR916Q provides features designed to enhance image quality at the display. The high speed serial bus scheme of FPD-Link II greatly eases system design by eliminating skew problems between clock and data, reduces the number of connector pins, reduces the interconnect size, weight, and cost, and overall eases PCB layout. In addition, internal DC balanced decoding is used to support AC-coupled interconnects.

The DS90UR916Q Des (deserializer) recovers the data (RGB) and control signals and extracts the clock from the serial stream. The Des locks to the incoming serial data stream without the use of a training sequence or special SYNC patterns, and does not require a reference clock. A link status (LOCK) output signal is provided. The DS90UR916Q is ideally suited for 24-bit color applications. White balance lookup tables and adaptive Hi-FRC dithering provide the user a cost-effective means to enhance display image quality.

Serial transmission is optimized with user selectable receiver equalization. EMI is minimized by the use of low voltage differential signaling, output slew control, and the Des may be configured to generate Spread Spectrum Clock and Data on its parallel outputs.

The DS90UR916Q is offered in a 60-pin WQFN package. It is specified over the automotive AEC-Q100 grade 2 temperature range of -40°C to +105°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

All trademarks are the property of their respective owners.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of the Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

Copyright © 2011–2013, Texas Instruments Incorporated

## Applications Diagram

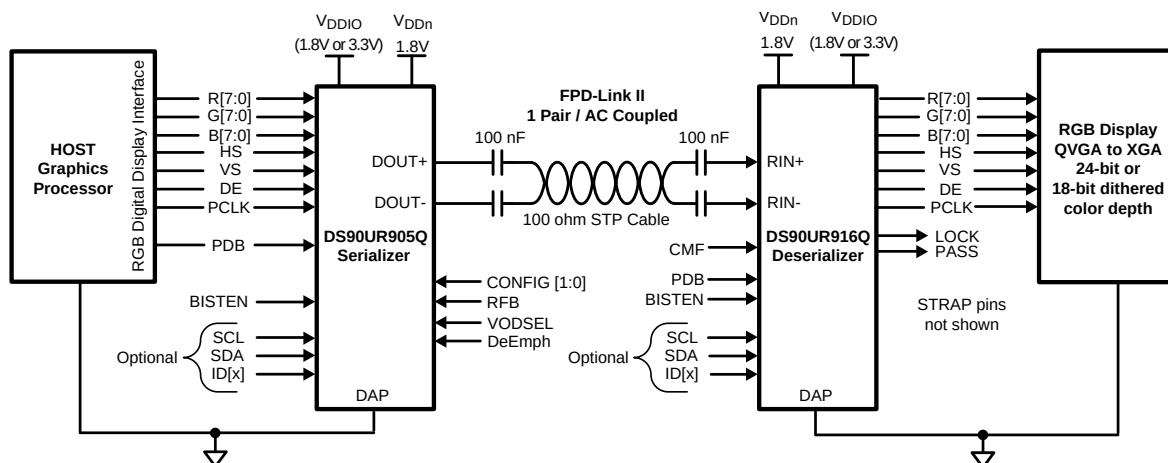


Figure 1.

## Block Diagrams

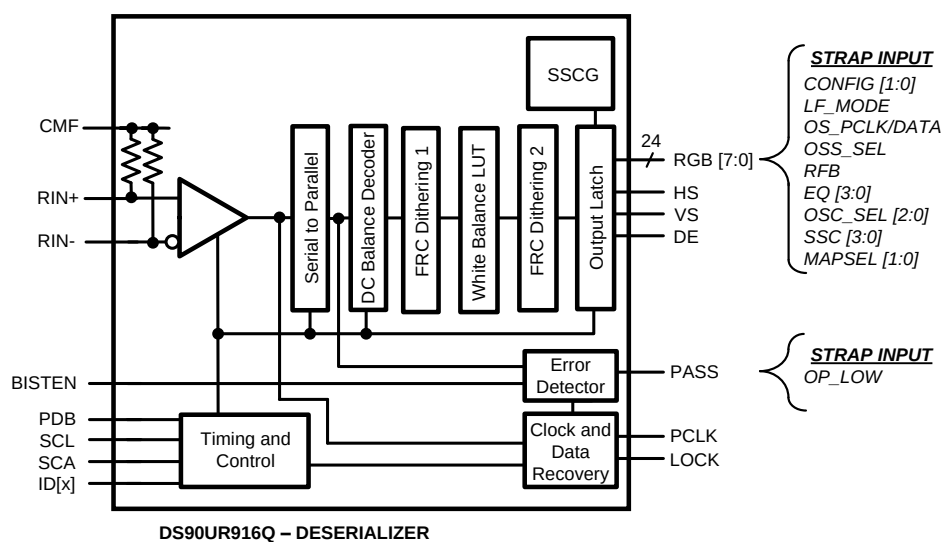


Figure 2.

## DS90UR916Q Pin Diagram

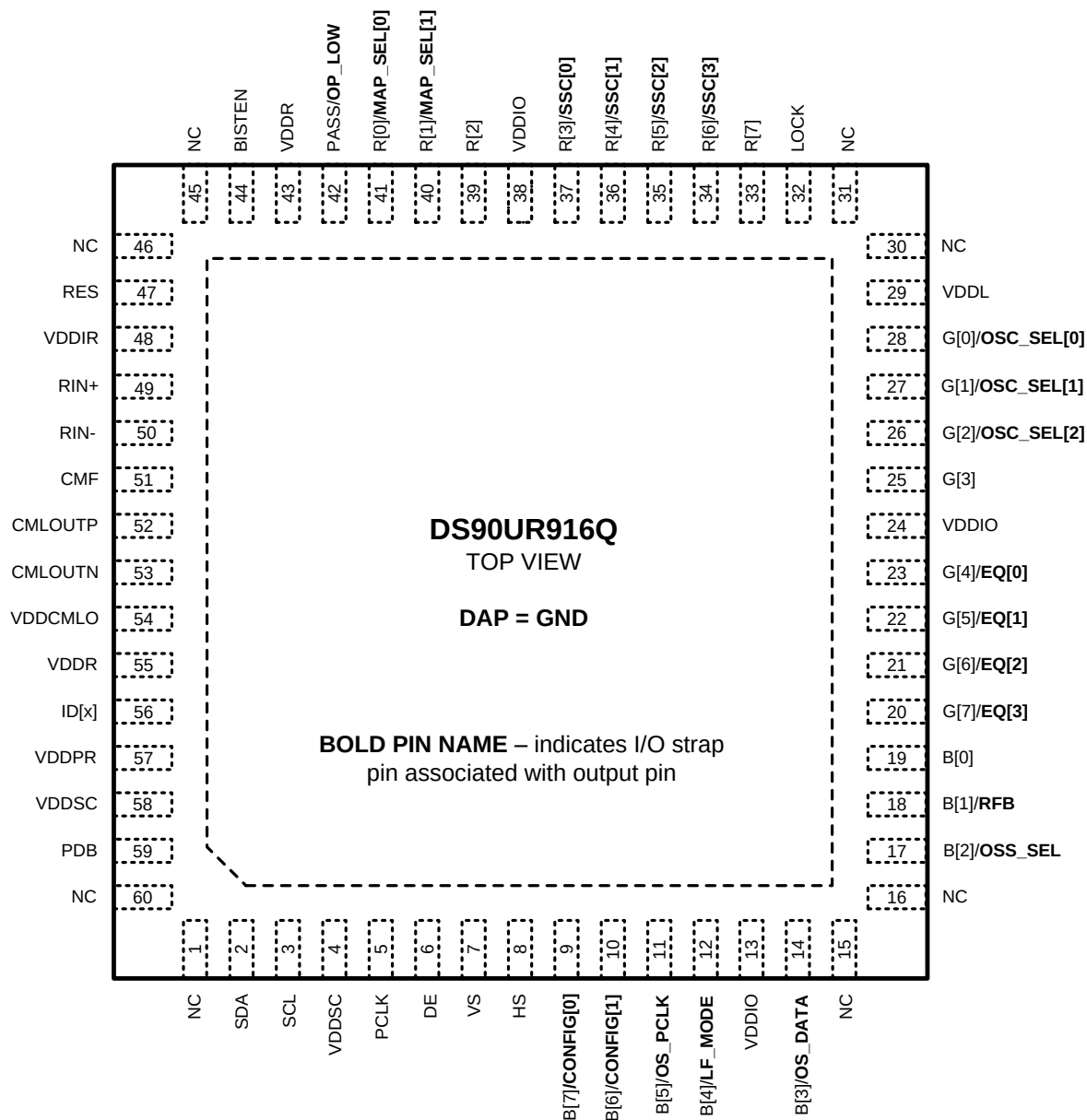


Figure 3. Deserializer - DS90UR916Q — Top View

**DS90UR916Q Deserializer Pin Descriptions<sup>(1)</sup>**

| Pin Name                                                                                                                                                                                                                                                         | Pin #                                | I/O, Type                           | Description                                                                                                                                                                                                                                                                                                                                                                                                                       |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------|-------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>LVC MOS Parallel Interface</b>                                                                                                                                                                                                                                |                                      |                                     |                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| R[7:0]                                                                                                                                                                                                                                                           | 33, 34, 35,<br>36, 37, 39,<br>40, 41 | I, STRAP,<br>O, LVC MOS             | RED Parallel Interface Data Output Pins (MSB = 7, LSB = 0)<br>In power-down (PDB = 0), outputs are controlled by the OSS_SEL (See Table 5). These pins are inputs during power-up (See STRAP Inputs).                                                                                                                                                                                                                             |
| G[7:0]                                                                                                                                                                                                                                                           | 20, 21, 22,<br>23, 25, 26,<br>27, 28 | I, STRAP,<br>O, LVC MOS             | GREEN Parallel Interface Data Output Pins (MSB = 7, LSB = 0)<br>In power-down (PDB = 0), outputs are controlled by the OSS_SEL (See Table 5). These pins are inputs during power-up (See STRAP Inputs).                                                                                                                                                                                                                           |
| B[7:0]                                                                                                                                                                                                                                                           | 9, 10, 11,<br>12, 14, 17,<br>18, 19  | I, STRAP,<br>O, LVC MOS             | BLUE Parallel Interface Data Output Pins (MSB = 7, LSB = 0)<br>In power-down (PDB = 0), outputs are controlled by the OSS_SEL (See Table 5). These pins are inputs during power-up (See STRAP Inputs).                                                                                                                                                                                                                            |
| HS                                                                                                                                                                                                                                                               | 8                                    | O, LVC MOS                          | Horizontal Sync Output<br>In power-down (PDB = 0), output is controlled by the OSS_SEL pin (See Table 5). Video control signal pulse width must be 3 PCLKs or longer to be transmitted when the Control Signal Filter is enabled (CONFIG[1:0] = 01). There is no restriction on the minimum transition pulse when the Control Signal Filter is disabled (CONFIG[1:0] = 00). The signal is limited to 2 transitions per 130 PCLKs. |
| VS                                                                                                                                                                                                                                                               | 7                                    | O, LVC MOS                          | Vertical Sync Output<br>In power-down (PDB = 0), output is controlled by the OSS_SEL pin (See Table 5). Video control signal is limited to 1 transition per 130 PCLKs. Thus, the minimum pulse width is 130 PCLKs.                                                                                                                                                                                                                |
| DE                                                                                                                                                                                                                                                               | 6                                    | O, LVC MOS                          | Data Enable Output<br>In power-down (PDB = 0), output is controlled by the OSS_SEL pin (See Table 5). Video control signal pulse width must be 3 PCLKs or longer to be transmitted when the Control Signal Filter is enabled (CONFIG[1:0] = 01). There is no restriction on the minimum transition pulse when the Control Signal Filter is disabled (CONFIG[1:0] = 00). The signal is limited to 2 transitions per 130 PCLKs.     |
| PCLK                                                                                                                                                                                                                                                             | 5                                    | O, LVC MOS                          | Pixel Clock Output<br>In power-down (PDB = 0), output is controlled by the OSS_SEL pin (See Table 5). Strobe edge set by RFB function.                                                                                                                                                                                                                                                                                            |
| LOCK                                                                                                                                                                                                                                                             | 32                                   | O, LVC MOS                          | LOCK Status Output<br>LOCK = 1, PLL is Locked, outputs are active LOCK = 0, PLL is unlocked, RGB[7:0], HS, VS, DE and PCLK output states are controlled by OSS_SEL (See Table 5). May be used as Link Status or to flag when Video Data is active (ON/OFF).                                                                                                                                                                       |
| PASS                                                                                                                                                                                                                                                             | 42                                   | O, LVC MOS                          | PASS Output (BIST Mode)<br>PASS = 1, error free transmission<br>PASS = 0, one or more errors were detected in the received payload<br>Route to test point for monitoring, or leave open if unused.                                                                                                                                                                                                                                |
| <b>Control and Configuration — STRAP PINS</b>                                                                                                                                                                                                                    |                                      |                                     |                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| For a High State, use a 10 kΩ pull up to V <sub>DDIO</sub> ; for a Low State, the IO includes an internal pull down. The STRAP pins are read upon power-up and set device configuration. Pin Number listed along with shared RGB Output name in square brackets. |                                      |                                     |                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| CONFIG[1:0]                                                                                                                                                                                                                                                      | 10 [B6],<br>9 [B7]                   | STRAP<br>I, LVC MOS<br>w/ pull-down | Operating Modes — Pin or Register Control<br>These pins determine the DS90UR916's operating mode and interfacing device.<br>CONFIG[1:0] = 00: Interfacing to DS90UR905, Control Signal Filter DISABLED<br>CONFIG[1:0] = 01: Interfacing to DS90UR905, Control Signal Filter ENABLED<br>CONFIG[1:0] = 10: Interfacing to DS90UR241<br>CONFIG[1:0] = 11: Interfacing to DS90C241                                                    |
| LF_MODE                                                                                                                                                                                                                                                          | 12 [B4]                              | STRAP<br>I, LVC MOS<br>w/ pull-down | SSCG Low Frequency Mode — Pin or Register Control<br>Only required when SSCG is enabled, otherwise LF_MODE condition is a DON'T CARE (X).<br>LF_MODE = 1, SSCG in low frequency mode (PCLK = 5-20 MHz)<br>LF_MODE = 0, SSCG in high frequency mode (PCLK = 20-65 MHz)                                                                                                                                                             |
| OS_PCLK                                                                                                                                                                                                                                                          | 11 [B5]                              | STRAP<br>I, LVC MOS<br>w/ pull-down | PCLK Output Slew Select — Pin or Register Control<br>OS_PCLK = 1, increased PCLK slew<br>OS_PCLK = 0, normal (default)                                                                                                                                                                                                                                                                                                            |
| OS_DATA                                                                                                                                                                                                                                                          | 14 [B3]                              | STRAP<br>I, LVC MOS<br>w/ pull-down | Data Output Slew Select — Pin or Register Control<br>OS_DATA = 1, increased DATA slew<br>OS_DATA = 0, normal (default)                                                                                                                                                                                                                                                                                                            |

(1) 1 = HIGH, 0 = LOW.

**DS90UR916Q Deserializer Pin Descriptions<sup>(1)</sup> (continued)**

| Pin Name                         | Pin #                                       | I/O, Type                          | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|----------------------------------|---------------------------------------------|------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| OP_LOW                           | 42 PASS                                     | STRAP<br>I, LVCMOS<br>w/ pull-down | Outputs held Low when LOCK = 1 — Pin or Register Control<br>NOTE: IT IS NOT RECOMMENDED TO USE ANY OTHER STRAP OPTIONS WITH THIS STRAP FUNCTION<br>OP_LOW = 1: all outputs are held LOW during power up until released by programming OP_LOW release/set register HIGH<br>NOTE: Before the device is powered up, the outputs are in tri-state.<br>See <a href="#">Figure 23</a> and <a href="#">Figure 24</a> .<br>OP_LOW = 0: all outputs toggle normally as soon as LOCK goes HIGH (default). |
| OSS_SEL                          | 17 [B2]                                     | STRAP<br>I, LVCMOS<br>w/ pull-down | Output Sleep State Select — Pin or Register Control<br>NOTE: OSS_SEL STRAP CANNOT BE USED IF OP_LOW = 1<br>OSS_SEL is used in conjunction with PDB to determine the state of the outputs when inactive. (See <a href="#">Table 5</a> ).                                                                                                                                                                                                                                                         |
| RFB                              | 18 [B1]                                     | STRAP<br>I, LVCMOS<br>w/ pull-down | Pixel Clock Output Strobe Edge Select — Pin or Register Control<br>RFB = 1, parallel interface data and control signals are strobed on the rising clock edge.<br>RFB = 0, parallel interface data and control signals are strobed on the falling clock edge.                                                                                                                                                                                                                                    |
| EQ[3:0]                          | 20 [G7],<br>21 [G6],<br>22 [G5],<br>23 [G4] | STRAP<br>I, LVCMOS<br>w/ pull-down | Receiver Input Equalization — Pin or Register Control<br>(See <a href="#">Table 2</a> ).                                                                                                                                                                                                                                                                                                                                                                                                        |
| OSC_SEL[2:0]                     | 26 [G2],<br>27 [G1],<br>28 [G0]             | STRAP<br>I, LVCMOS<br>w/ pull-down | Oscillator Select — Pin or Register Control<br>(See <a href="#">Table 6</a> and <a href="#">Table 7</a> ).                                                                                                                                                                                                                                                                                                                                                                                      |
| SSC[3:0]                         | 34 [R6],<br>35 [R5],<br>36 [R4],<br>37 [R3] | STRAP<br>I, LVCMOS<br>w/ pull-down | Spread Spectrum Clock Generation (SSCG) Range Select — Pin or Register Control<br>(See <a href="#">Table 3</a> and <a href="#">Table 4</a> ).                                                                                                                                                                                                                                                                                                                                                   |
| MAP_SEL[1:0]                     | 40 [R1],<br>41 [R0]                         | STRAP<br>I, LVCMOS<br>w/ pull-down | Bit Mapping Backward Compatibility / DS90UR241 Options — Pin or Register Control<br>Normal setting to b'00. See ( <a href="#">Table 8</a> ).                                                                                                                                                                                                                                                                                                                                                    |
| <b>Control and Configuration</b> |                                             |                                    |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| PDB                              | 59                                          | I, LVCMOS<br>w/ pull-down          | Power Down Mode Input<br>PDB = 1, Des is enabled (normal operation).<br>Refer to <a href="#">POWER UP REQUIREMENTS AND PDB PIN</a> in the Applications Information Section.<br>PDB = 0, Des is in power-down.<br>When the Des is in the power-down state, the LVCMOS output state is determined by <a href="#">Table 5</a> . Control Registers are <b>RESET</b> .                                                                                                                               |
| ID[x]                            | 56                                          | I, Analog                          | Serial Control Bus Device ID Address Select — Optional<br>Resistor to Ground and 10 kΩ pull-up to 1.8V rail. (See <a href="#">Table 9</a> ).                                                                                                                                                                                                                                                                                                                                                    |
| SCL                              | 3                                           | I, LVCMOS                          | Serial Control Bus Clock Input - Optional<br>SCL requires an external pull-up resistor to V <sub>DDIO</sub> .                                                                                                                                                                                                                                                                                                                                                                                   |
| SDA                              | 2                                           | I/O, LVCMOS<br>Open Drain          | Serial Control Bus Data Input / Output - Optional<br>SDA requires an external pull-up resistor to V <sub>DDIO</sub> .                                                                                                                                                                                                                                                                                                                                                                           |
| BISTEN                           | 44                                          | I, LVCMOS<br>w/ pull-down          | BIST Enable Input — Optional<br>BISTEN = 1, BIST is enabled<br>BISTEN = 0, BIST is disabled                                                                                                                                                                                                                                                                                                                                                                                                     |
| RES                              | 47                                          | I, LVCMOS<br>w/ pull-down          | <b>Reserved</b> - tie LOW                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| NC                               | 1, 15, 16,<br>30, 31, 45,<br>46, 60         |                                    | Not Connected<br>Leave pin open (float)                                                                                                                                                                                                                                                                                                                                                                                                                                                         |

**DS90UR916Q Deserializer Pin Descriptions<sup>(1)</sup> (continued)**

| Pin Name                              | Pin #      | I/O, Type | Description                                                                                                                                                                             |
|---------------------------------------|------------|-----------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>FPD-Link II Serial Interface</b>   |            |           |                                                                                                                                                                                         |
| RIN+                                  | 49         | I, LVDS   | True Input. The input must be AC Coupled with a 100 nF capacitor.                                                                                                                       |
| RIN-                                  | 50         | I, LVDS   | Inverting Input. The input must be AC Coupled with a 100 nF capacitor.                                                                                                                  |
| CMF                                   | 51         | I, Analog | Common-Mode Filter<br>VCM center-tap is a virtual ground which may be ac-coupled to ground to increase receiver common mode noise immunity. Recommended value is 4.7 $\mu$ F or higher. |
| CMLOUTP                               | 52         | O, LVDS   | Test Monitor Pin — EQ Waveform<br>NC or connect to test point. Requires Serial Bus Control to enable.                                                                                   |
| CMLOUTN                               | 53         | O, LVDS   | Test Monitor Pin — EQ Waveform<br>NC or connect to test point. Requires Serial Bus Control to enable.                                                                                   |
| <b>Power and Ground<sup>(2)</sup></b> |            |           |                                                                                                                                                                                         |
| VDDL                                  | 29         | Power     | Logic Power, 1.8 V $\pm$ 5%                                                                                                                                                             |
| VDDIR                                 | 48         | Power     | Input Power, 1.8 V $\pm$ 5%                                                                                                                                                             |
| VDDR                                  | 43, 55     | Power     | RX High Speed Logic Power, 1.8 V $\pm$ 5%                                                                                                                                               |
| VDDSC                                 | 4, 58      | Power     | SSCG Power, 1.8 V $\pm$ 5%                                                                                                                                                              |
| VDDPR                                 | 57         | Power     | PLL Power, 1.8 V $\pm$ 5%                                                                                                                                                               |
| VDDCMLO                               | 54         | Power     | RX High Speed Logic Power, 1.8 V $\pm$ 5%                                                                                                                                               |
| VDDIO                                 | 13, 24, 38 | Power     | LVCMOS I/O Power, <b>1.8 V <math>\pm</math>5% OR 3.3 V <math>\pm</math>10%</b> (V <sub>DDIO</sub> )                                                                                     |
| GND                                   | DAP        | Ground    | DAP is the large metal contact at the bottom side, located at the center of the WQFN package. <b>Connected to the ground plane (GND)</b> with at least 9 vias.                          |

- (2) The VDD (V<sub>DDn</sub> and V<sub>DDIO</sub>) supply ramp should be faster than 1.5 ms with a monotonic rise. If slower than 1.5 ms then a capacitor on the PDB pin is needed to ensure PDB arrives after all the VDD have settled to the recommended operating voltage.



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

## Absolute Maximum Ratings<sup>(1)(2)</sup>

|                                                                                                                                                                      |                                                  |                           |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------|---------------------------|
| Supply Voltage – $V_{DDn}$ (1.8V)                                                                                                                                    |                                                  | –0.3V to +2.5V            |
| Supply Voltage – $V_{DDIO}$                                                                                                                                          |                                                  | –0.3V to +4.0V            |
| LVCMOS I/O Voltage                                                                                                                                                   |                                                  | –0.3V to +(VDDIO + 0.3V)  |
| Receiver Input Voltage                                                                                                                                               |                                                  | –0.3V to (VDD + 0.3V)     |
| Junction Temperature                                                                                                                                                 |                                                  | +150°C                    |
| Storage Temperature                                                                                                                                                  |                                                  | –65°C to +150°C           |
| 60L WQFN Package                                                                                                                                                     | Maximum Power Dissipation Capacity at 25°C 470mW | 470mW                     |
|                                                                                                                                                                      | Derate above 25C                                 | 1/θ <sub>JA</sub> mW / °C |
|                                                                                                                                                                      | θ <sub>JA</sub> (based on 9 thermal vias)        | 24.6 °C/W                 |
|                                                                                                                                                                      | θ <sub>JC</sub> (based on 9 thermal vias)        | 2.8 °C/W                  |
| ESD Rating (HBM)                                                                                                                                                     |                                                  | ≥±8 kV                    |
| ESD Rating (CDM)                                                                                                                                                     |                                                  | ≥±1 kV                    |
| ESD Rating (MM)                                                                                                                                                      |                                                  | ≥±250 V                   |
| ESD Rating (ISO10605), R <sub>D</sub> = 2kΩ, C <sub>S</sub> = 150pF or R <sub>D</sub> = 2kΩ, C <sub>S</sub> = 330pF or R <sub>D</sub> = 330Ω, C <sub>S</sub> = 150pF |                                                  |                           |
| Air Discharge (R <sub>IN+</sub> , R <sub>IN-</sub> )                                                                                                                 |                                                  | ≥±30 kV                   |
| Contact Discharge (R <sub>IN+</sub> , R <sub>IN-</sub> )                                                                                                             |                                                  | ≥±10 kV                   |
| ESD Rating (ISO10605), R <sub>D</sub> = 330Ω, C <sub>S</sub> = 330pF                                                                                                 |                                                  |                           |
| Air Discharge (R <sub>IN+</sub> , R <sub>IN-</sub> )                                                                                                                 |                                                  | ≥±15 kV                   |
| Contact Discharge (R <sub>IN+</sub> , R <sub>IN-</sub> )                                                                                                             |                                                  | ≥±10 kV                   |
| ESD Rating (IEC 61000–4–2), R <sub>D</sub> = 330Ω, C <sub>S</sub> = 150pF                                                                                            |                                                  |                           |
| Air Discharge (R <sub>IN+</sub> , R <sub>IN-</sub> )                                                                                                                 |                                                  | ≥±25 kV                   |
| Contact Discharge (R <sub>IN+</sub> , R <sub>IN-</sub> )                                                                                                             |                                                  | ≥±10 kV                   |
| For soldering specifications see product folder at <a href="http://www.ti.com">www.ti.com</a> and SNOA549                                                            |                                                  |                           |

- (1) “Absolute Maximum Ratings” indicate limits beyond which damage to the device may occur, including inoperability and degradation of device reliability and/or performance. Functional operation of the device and/or non-degradation at the Absolute Maximum Ratings or other conditions beyond those indicated in the [Recommended Operating Conditions](#) is not implied. The Recommended Operating Conditions indicate conditions at which the device is functional and the device should not be operated beyond such conditions.
- (2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/ Distributors for availability and specifications.

## Recommended Operating Conditions

|                                                  | Min  | Nom | Max  | Units             |
|--------------------------------------------------|------|-----|------|-------------------|
| Supply Voltage ( $V_{DDn}$ )                     | 1.71 | 1.8 | 1.89 | V                 |
| LVCMOS Supply Voltage ( $V_{DDIO}$ )             | 1.71 | 1.8 | 1.89 | V                 |
| <b>OR</b>                                        |      |     |      |                   |
| LVCMOS Supply Voltage ( $V_{DDIO}$ )             | 3.0  | 3.3 | 3.6  | V                 |
| Operating Free Air Temperature (T <sub>A</sub> ) | –40  | +25 | +105 | °C                |
| PCLK Clock Frequency                             | 5    |     | 65   | MHz               |
| Supply Noise <sup>(1)</sup>                      |      |     | 50   | mV <sub>p-p</sub> |

- (1) Supply noise testing was done with minimum capacitors on the PCB. A sinusoidal signal is AC coupled to the  $V_{DDn}$  (1.8V) supply with amplitude = 100 mVp-p measured at the device  $V_{DDn}$  pins. Bit error rate testing of input to the Ser and output of the Des with 10 meter cable shows no error when the noise frequency on the Ser is less than 750 kHz. The Des on the other hand shows no error when the noise frequency is less than 400 kHz.

## Deserializer DC Electrical Characteristics<sup>(1)(2)(3)</sup>

Over recommended operating supply and temperature ranges unless otherwise specified.

| Symbol                                                                                         | Parameter                                 | Conditions                                                | Pin/Freq.                                            | Min               | Typ        | Max        | Units |
|------------------------------------------------------------------------------------------------|-------------------------------------------|-----------------------------------------------------------|------------------------------------------------------|-------------------|------------|------------|-------|
| <b>3.3 V I/O LVCMOS DC SPECIFICATIONS – <math>V_{DDIO} = 3.0</math> to <math>3.6V</math></b>   |                                           |                                                           |                                                      |                   |            |            |       |
| $V_{IH}$                                                                                       | High Level Input Voltage                  |                                                           | PDB, BISTEN                                          | 2.2               |            | $V_{DDIO}$ | V     |
| $V_{IL}$                                                                                       | Low Level Input Voltage                   |                                                           |                                                      | GND               |            | 0.8        | V     |
| $I_{IN}$                                                                                       | Input Current                             | $V_{IN} = 0V$ or $V_{DDIO}$                               |                                                      | -15               | ±1         | +15        | μA    |
| $V_{OH}$                                                                                       | High Level Output Voltage                 | $I_{OH} = -2$ mA, OS_PCLK/DATA = L                        | R[7:0], G[7:0], B[7:0], HS, VS, DE, PCLK, LOCK, PASS | 2.4               | $V_{DDIO}$ |            | V     |
| $V_{OL}$                                                                                       | Low Level Output Voltage                  | $I_{OL} = +2$ mA, OS_PCLK/DATA = L                        | R[7:0], G[7:0], B[7:0], HS, VS, DE, PCLK, LOCK, PASS | GND               |            | 0.4        | V     |
| $I_{OS}$                                                                                       | Output Short Circuit Current              | $V_{DDIO} = 3.3V$<br>$V_{OUT} = 0V$ , OS_PCLK/DATA = L/H  | PCLK                                                 |                   | 36         |            | mA    |
|                                                                                                | Output Short Circuit Current              | $V_{DDIO} = 3.3V$<br>$V_{OUT} = 0V$<br>OS_PCLK/DATA = L/H | Des Outputs                                          |                   | 37         |            | mA    |
| $I_{OZ}$                                                                                       | TRI-STATE® Output Current                 | PDB = 0V, OSS_SEL = 0V,<br>$V_{OUT} = 0V$ or $V_{DDIO}$   | Outputs                                              | -15               |            | +15        | μA    |
| <b>1.8 V I/O LVCMOS DC SPECIFICATIONS – <math>V_{DDIO} = 1.71</math> to <math>1.89V</math></b> |                                           |                                                           |                                                      |                   |            |            |       |
| $V_{IH}$                                                                                       | High Level Input Voltage                  |                                                           | PDB, BISTEN                                          | 1.235             |            | $V_{DDIO}$ | V     |
| $V_{IL}$                                                                                       | Low Level Input Voltage                   |                                                           |                                                      | GND               |            | 0.595      | V     |
| $I_{IN}$                                                                                       | Input Current                             | $V_{IN} = 0V$ or $V_{DDIO}$                               |                                                      | -15               | ±1         | +15        | μA    |
| $V_{OH}$                                                                                       | High Level Output Voltage                 | $I_{OH} = -2$ mA, OS_PCLK/DATA = L                        | R[7:0], G[7:0], B[7:0], HS, VS, DE, PCLK, LOCK, PASS | $V_{DDIO} - 0.45$ | $V_{DDIO}$ |            | V     |
| $V_{OL}$                                                                                       | Low Level Output Voltage                  | $I_{OL} = +2$ mA, OS_PCLK/DATA = L                        | R[7:0], G[7:0], B[7:0], HS, VS, DE, PCLK, LOCK, PASS | GND               |            | 0.45       | V     |
| $I_{OS}$                                                                                       | Output Short Circuit Current              | $V_{DDIO} = 1.8V$<br>$V_{OUT} = 0V$<br>OS_PCLK/DATA = L/H | PCLK                                                 |                   | 18         |            | mA    |
|                                                                                                | Output Short Circuit Current              | $V_{DDIO} = 1.8V$<br>$V_{OUT} = 0V$<br>OS_PCLK/DATA = L/H | Des Outputs                                          |                   | 18         |            | mA    |
| $I_{OZ}$                                                                                       | TRI-STATE® Output Current                 | PDB = 0V, OSS_SEL = 0V,<br>$V_{OUT} = 0V$ or $V_{DDIO}$   | Outputs                                              | -15               |            | +15        | μA    |
| $V_{TH}$                                                                                       | Differential Input Threshold High Voltage | $V_{CM} = +1.2V$ (Internal $V_{BIAS}$ )                   | RIN+, RIN-                                           | +50               |            |            | mV    |
| $V_{TL}$                                                                                       | Differential Input Threshold Low Voltage  |                                                           |                                                      | -50               |            |            | mV    |
| $V_{CM}$                                                                                       | Common Mode Voltage, Internal $V_{BIAS}$  |                                                           |                                                      |                   | 1.2        |            | V     |
| $I_{IN}$                                                                                       | Input Current                             | $V_{IN} = 0V$ or $V_{DDIO}$                               |                                                      | -15               |            | +15        | μA    |
| $R_T$                                                                                          | Internal Termination Resistor             |                                                           |                                                      | 80                | 100        | 120        | Ω     |

- (1) Current into device pins is defined as positive. Current out of a device pin is defined as negative. Voltages are referenced to ground except VOD, ΔVOD, VTH and VTL which are differential voltages.
- (2) Typical values represent most likely parametric norms at  $V_{DD} = 3.3V$ ,  $T_a = +25$  degC, and at the Recommended Operation Conditions at the time of product characterization and are not ensured.
- (3) The Electrical Characteristics tables list ensured specifications under the listed Recommended Operating Conditions except as otherwise modified or specified by the Electrical Characteristics Conditions and/or Notes. Typical specifications are estimations only and are not ensured.

## Deserializer DC Electrical Characteristics<sup>(1)(2)(3)</sup> (continued)

Over recommended operating supply and temperature ranges unless otherwise specified.

| Symb<br>ol                                         | Parameter                                           | Conditions                                                                                                                  |                          | Pin/Freq.                | Min | Typ | Max  | Units |
|----------------------------------------------------|-----------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------|--------------------------|--------------------------|-----|-----|------|-------|
| CML DRIVER OUTPUT DC SPECIFICATIONS – EQ TEST PORT |                                                     |                                                                                                                             |                          |                          |     |     |      |       |
| V <sub>OD</sub>                                    | Differential Output Voltage                         | R <sub>L</sub> = 100Ω                                                                                                       |                          | CMLOUTP,<br>CMLOUTN      |     | 542 |      | mV    |
| V <sub>OS</sub>                                    | Offset Voltage Single-ended                         | R <sub>L</sub> = 100Ω                                                                                                       |                          |                          |     | 1.4 |      | V     |
| R <sub>T</sub>                                     | Internal Termination Resistor                       |                                                                                                                             |                          |                          | 80  | 100 | 120  | Ω     |
| SUPPLY CURRENT                                     |                                                     |                                                                                                                             |                          |                          |     |     |      |       |
| I <sub>DD1</sub>                                   | Deserializer Supply Current (includes load current) | Checker Board Pattern, OS_PCLK/DATA = H, EQ = 001, SSCG=ON,CMLOUTP/N enabled C <sub>L</sub> = 4pF, <a href="#">Figure 4</a> | V <sub>DD</sub> = 1.89V  | All V <sub>DD</sub> pins |     | 93  | 110  | mA    |
| I <sub>DDIO1</sub>                                 |                                                     |                                                                                                                             | V <sub>DDIO</sub> =1.89V | V <sub>DDIO</sub>        |     | 33  | 45   | mA    |
|                                                    |                                                     |                                                                                                                             | V <sub>DDIO</sub> = 3.6V |                          |     | 62  | 75   | mA    |
| I <sub>DDZ</sub>                                   | Deserializer Supply Current Power Down              | PDB = 0V, All other LVCMOS Inputs = 0V                                                                                      | V <sub>DD</sub> = 1.89V  | All V <sub>DD</sub> pins |     | 40  | 3000 | μA    |
| I <sub>DDIOZ</sub>                                 |                                                     |                                                                                                                             | V <sub>DDIO</sub> =1.89V | V <sub>DDIO</sub>        |     | 5   | 50   | μA    |
|                                                    |                                                     |                                                                                                                             | V <sub>DDIO</sub> = 3.6V |                          |     | 10  | 100  | μA    |

## Deserializer Switching Characteristics

Over recommended operating supply and temperature ranges unless otherwise specified.

| Symbol                          | Parameter                                                      | Conditions                                                                              | Pin/Freq.                 | Min   | Typ   | Max   | Units            |
|---------------------------------|----------------------------------------------------------------|-----------------------------------------------------------------------------------------|---------------------------|-------|-------|-------|------------------|
| t <sub>RCP</sub>                | PCLK Output Period                                             |                                                                                         | PCLK                      | 15.38 | T     | 200   | ns               |
| t <sub>RDC</sub>                | PCLK Output Duty Cycle                                         | SSCG=OFF, 5–65MHz                                                                       | PCLK                      | 43    | 50    | 57    | %                |
|                                 |                                                                | SSCG=ON, 5–20MHz                                                                        |                           | 35    | 59    | 65    | %                |
|                                 |                                                                | SSCG=ON, 20–65MHz                                                                       |                           | 40    | 53    | 60    | %                |
| t <sub>CLH</sub>                | LVCMOS Low-to-High Transition Time, <a href="#">Figure 5</a>   | V <sub>DDIO</sub> = 1.8V<br>C <sub>L</sub> = 4 pF (lumped load)                         | PCLK/RGB[7:0], HS, VS, DE |       | 2.1   |       | ns               |
|                                 |                                                                | V <sub>DDIO</sub> = 3.3V<br>C <sub>L</sub> = 4 pF (lumped load)                         |                           |       | 2.0   |       | ns               |
| t <sub>CHL</sub>                | LVCMOS High-to-Low Transition Time, <a href="#">Figure 5</a>   | V <sub>DDIO</sub> = 1.8V<br>C <sub>L</sub> = 4 pF (lumped load)                         | PCLK/RGB[7:0], HS, VS, DE |       | 1.6   |       | ns               |
|                                 |                                                                | V <sub>DDIO</sub> = 3.3V<br>C <sub>L</sub> = 4 pF (lumped load)                         |                           |       | 1.5   |       | ns               |
| t <sub>ROS</sub>                | Data Valid before PCLK – Set Up Time, <a href="#">Figure 9</a> | V <sub>DDIO</sub> = 1.71 to 1.89V or 3.0 to 3.6V<br>C <sub>L</sub> = 4 pF (lumped load) | RGB[7:0], HS, VS, DE      | 0.27  | 0.45  |       | T                |
| t <sub>ROH</sub>                | Data Valid after PCLK – Hold Time, <a href="#">Figure 9</a>    | V <sub>DDIO</sub> = 1.71 to 1.89V or 3.0 to 3.6V<br>C <sub>L</sub> = 4 pF (lumped load) | RGB[7:0], HS, VS, DE      | 0.4   | 0.55  |       | T                |
| t <sub>HBLANK</sub>             | Horizontal Blanking Time                                       |                                                                                         | HS                        | 6     |       |       | t <sub>RCP</sub> |
| t <sub>DDLT</sub>               | Deserializer Lock Time, <a href="#">Figure 8</a>               | SSC[3:0] = 0000 (OFF) <sup>(1)</sup>                                                    | PCLK = 5 MHz              |       | 3     |       | ms               |
|                                 |                                                                | SSC[3:0] = 0000 (OFF) <sup>(1)</sup>                                                    | PCLK = 65MHz              |       | 4     |       | ms               |
|                                 |                                                                | SSC[3:0] = ON <sup>(1)</sup>                                                            | PCLK = 5MHz               |       | 30    |       | ms               |
|                                 |                                                                | SSC[3:0] = ON <sup>(1)</sup>                                                            | PCLK = 65MHz              |       | 6     |       | ms               |
| t <sub>DD</sub>                 | Des Delay - Latency, <a href="#">Figure 6</a>                  |                                                                                         |                           |       | 139*T | 140*T | ns               |
| t <sub>DPJ</sub> <sup>(2)</sup> | Des Period Jitter                                              | SSC[3:0] = OFF <sup>(3)(4)</sup>                                                        | PCLK = 5 MHz              |       | 975   | 1700  | ps               |
|                                 |                                                                |                                                                                         | PCLK = 10 MHz             |       | 500   | 1000  | ps               |
|                                 |                                                                |                                                                                         | PCLK = 65 MHz             |       | 550   | 1250  | ps               |

- (1) t<sub>PLD</sub> and t<sub>DDLT</sub> is the time required by the serializer and deserializer to obtain lock when exiting power-down state with an active PCLK.
- (2) Specification is ensured by design and is not tested in production.
- (3) t<sub>DPJ</sub> is the maximum amount the period is allowed to deviate over many samples.
- (4) Specification is ensured by characterization and is not tested in production.

## Deserializer Switching Characteristics (continued)

Over recommended operating supply and temperature ranges unless otherwise specified.

| Symbol                           | Parameter                                        | Conditions                               | Pin/Freq.                            | Min  | Typ | Max  | Units             |
|----------------------------------|--------------------------------------------------|------------------------------------------|--------------------------------------|------|-----|------|-------------------|
| t <sub>DCCJ</sub> <sup>(2)</sup> | Des Cycle-to-Cycle Jitter                        | SSC[3:0] = OFF <sup>(4)(5)</sup>         | PCLK = 5 MHz                         |      | 675 | 1150 | ps                |
|                                  |                                                  |                                          | PCLK = 10 MHz                        |      | 375 | 900  | ps                |
|                                  |                                                  |                                          | PCLK = 65 MHz                        |      | 500 | 1150 | ps                |
| t <sub>RJIT</sub>                | Des Input Jitter Tolerance,<br>Figure 11         | EQ = OFF,<br>SSCG = OFF,<br>PCLK = 65MHz | for jitter freq < 2MHz               |      | 0.9 |      | UI <sup>(6)</sup> |
|                                  |                                                  |                                          | for jitter freq > 6MHz               |      | 0.5 |      | UI                |
| BIST Mode                        |                                                  |                                          |                                      |      |     |      |                   |
| t <sub>PASS</sub>                | BIST PASS Valid Time,<br>BISTEN = 1, Figure 12   |                                          |                                      |      | 1   | 10   | ns                |
| SSCG Mode                        |                                                  |                                          |                                      |      |     |      |                   |
| f <sub>DEV</sub>                 | Spread Spectrum Clocking<br>Deviation Frequency  |                                          | PCLK = 5 to 65 MHz,<br>SSC[3:0] = ON | ±0.5 |     | ±2   | %                 |
| f <sub>MOD</sub>                 | Spread Spectrum Clocking<br>Modulation Frequency |                                          | PCLK = 5 to 65 MHz,<br>SSC[3:0] = ON | 8    |     | 100  | kHz               |

(5)  $t_{DCCJ}$  is the maximum amount of jitter between adjacent clock cycles.

(6) UI – Unit Interval is equivalent to one serialized data bit width ( $1UI = 1 / 28 \times PCLK$ ). The UI scales with PCLK frequency.

## Recommended Timing for the Serial Control Bus

Over +3.3V supply and temperature ranges unless otherwise specified.

| Symbol       | Parameter                                                                        | Conditions    | Min | Typ | Max  | Units |
|--------------|----------------------------------------------------------------------------------|---------------|-----|-----|------|-------|
| $f_{SCL}$    | SCL Clock Frequency                                                              | Standard Mode | >0  |     | 100  | kHz   |
|              |                                                                                  | Fast Mode     | >0  |     | 400  | kHz   |
| $t_{LOW}$    | SCL Low Period                                                                   | Standard Mode | 4.7 |     |      | us    |
|              |                                                                                  | Fast Mode     | 1.3 |     |      | us    |
| $t_{HIGH}$   | SCL High Period                                                                  | Standard Mode | 4.0 |     |      | us    |
|              |                                                                                  | Fast Mode     | 0.6 |     |      | us    |
| $t_{HD;STA}$ | Hold time for a start or a repeated start condition, <a href="#">Figure 13</a>   | Standard Mode | 4.0 |     |      | us    |
|              |                                                                                  | Fast Mode     | 0.6 |     |      | us    |
| $t_{SU;STA}$ | Set Up time for a start or a repeated start condition, <a href="#">Figure 13</a> | Standard Mode | 4.7 |     |      | us    |
|              |                                                                                  | Fast Mode     | 0.6 |     |      | us    |
| $t_{HD;DAT}$ | Data Hold Time, <a href="#">Figure 13</a>                                        | Standard Mode | 0   |     | 3.45 | us    |
|              |                                                                                  | Fast Mode     | 0   |     | 0.9  | us    |
| $t_{SU;DAT}$ | Data Set Up Time, <a href="#">Figure 13</a>                                      | Standard Mode | 250 |     |      | ns    |
|              |                                                                                  | Fast Mode     | 100 |     |      | ns    |
| $t_{SU;STO}$ | Set Up Time for STOP Condition, <a href="#">Figure 13</a>                        | Standard Mode | 4.0 |     |      | us    |
|              |                                                                                  | Fast Mode     | 0.6 |     |      | us    |
| $t_{BUF}$    | Bus Free Time Between STOP and START, <a href="#">Figure 13</a>                  | Standard Mode | 4.7 |     |      | us    |
|              |                                                                                  | Fast Mode     | 1.3 |     |      | us    |
| $t_r$        | SCL & SDA Rise Time, <a href="#">Figure 13</a>                                   | Standard Mode |     |     | 1000 | ns    |
|              |                                                                                  | Fast Mode     |     |     | 300  | ns    |
| $t_f$        | SCL & SDA Fall Time, <a href="#">Figure 13</a>                                   | Standard Mode |     |     | 300  | ns    |
|              |                                                                                  | Fast mode     |     |     | 300  | ns    |

## DC and AC Serial Control Bus Characteristics

Over 3.3V supply and temperature ranges unless otherwise specified.

| Symbol       | Parameter               | Conditions                             | Min | Typ | Max        | Units |
|--------------|-------------------------|----------------------------------------|-----|-----|------------|-------|
| $V_{IH}$     | Input High Level        | SDA and SCL                            | 2.2 |     | $V_{DDIO}$ | V     |
| $V_{IL}$     | Input Low Level Voltage | SDA and SCL                            | GND |     | 0.8        | V     |
| $V_{HY}$     | Input Hysteresis        |                                        |     | >50 |            | mV    |
| $V_{OL}$     |                         | SDA, IOL = 1.25mA                      | 0   |     | 0.4        | V     |
| $I_{in}$     |                         | SDA or SCL, $V_{in} = V_{DDIO}$ or GND | -15 |     | +15        | μA    |
| $t_R$        | SDA RiseTime – READ     | SDA, RPU = X, $C_b \leq 400pF$         |     | 40  |            | ns    |
| $t_F$        | SDA Fall Time – READ    |                                        |     | 25  |            | ns    |
| $t_{SU;DAT}$ | Set Up Time — READ      |                                        |     | 520 |            | ns    |
| $t_{HD;DAT}$ | Hold Up Time — READ     |                                        |     | 55  |            | ns    |
| $t_{SP}$     | Input Filter            |                                        |     | 50  |            | ns    |
| $C_{in}$     | Input Capacitance       | SDA or SCL                             |     | <5  |            | pF    |

## AC Timing Diagrams and Test Circuits

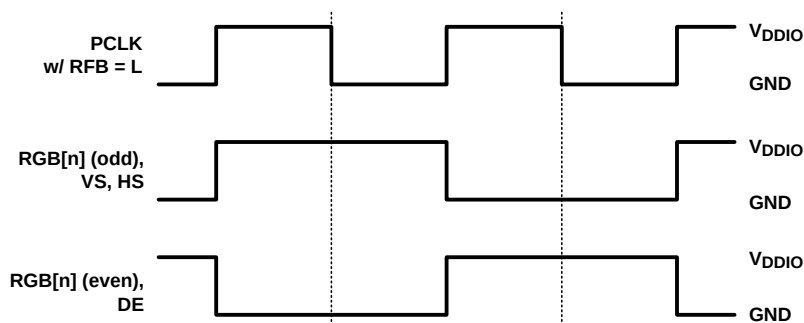


**Figure 4. Checkerboard Data Pattern**

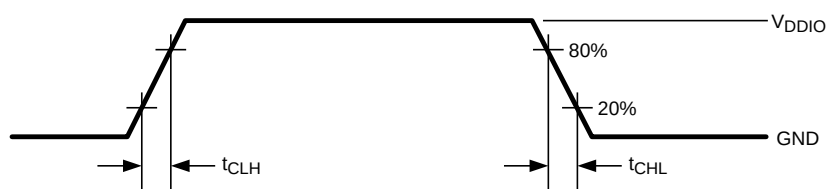


**Figure 5. Deserializer LVCMOS Transition Times**

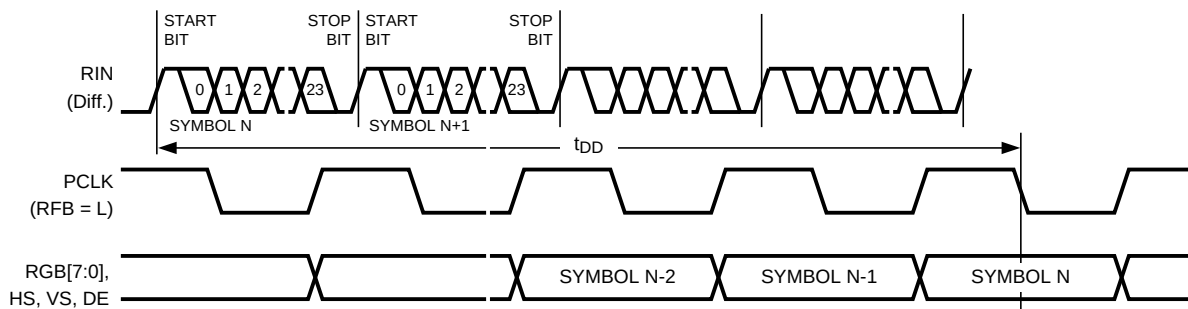


**Figure 6. Deserializer Delay – Latency**

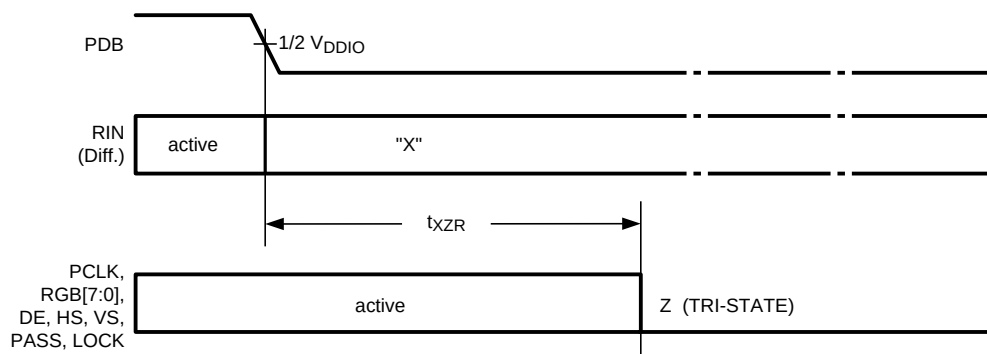


**Figure 7. Deserializer Disable Time (OSS\_SEL = 0)**

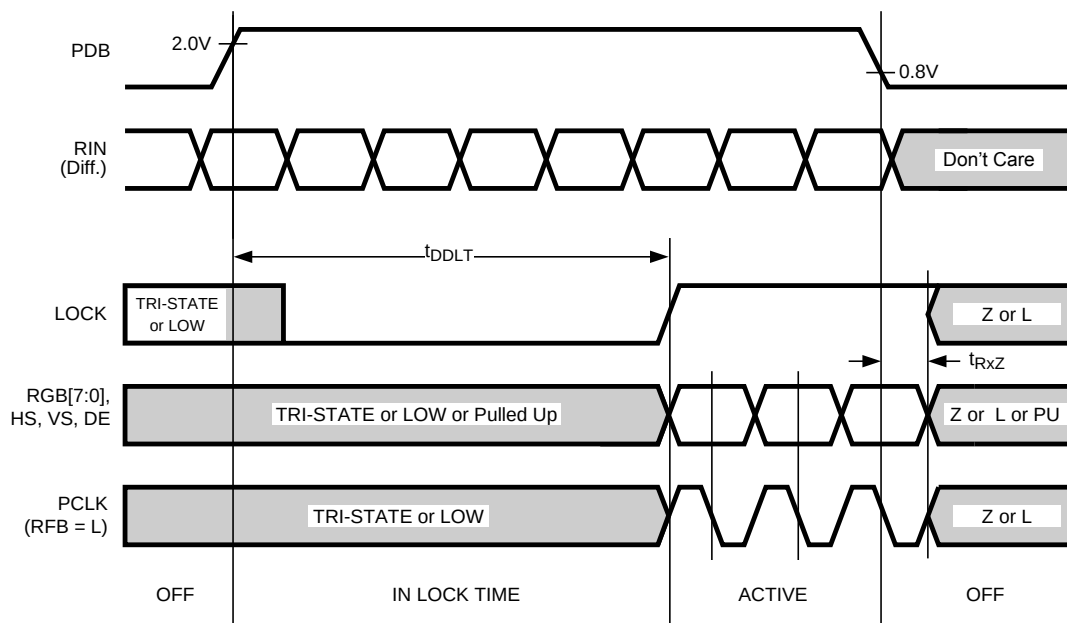


Figure 8. Deserializer PLL Lock Times and PDB TRI-STATE Delay<sup>(1)</sup>

Note: (1) When the Serializer output is at TRI-STATE the Deserializer will lose PLL lock. Resynchronization / Relock must occur before data transfer require  $t_{PLD}$

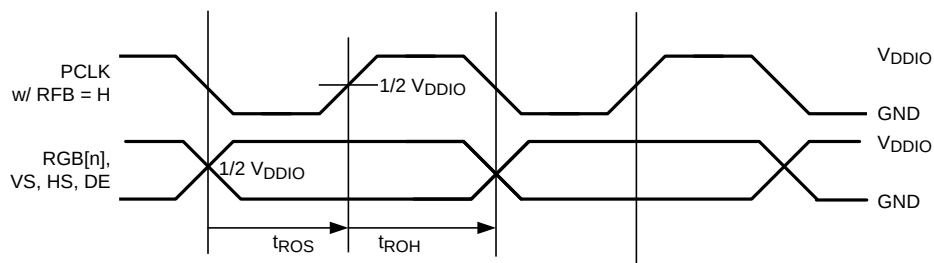


Figure 9. Deserializer Output Data Valid (Setup and Hold) Times with SSCG = Off

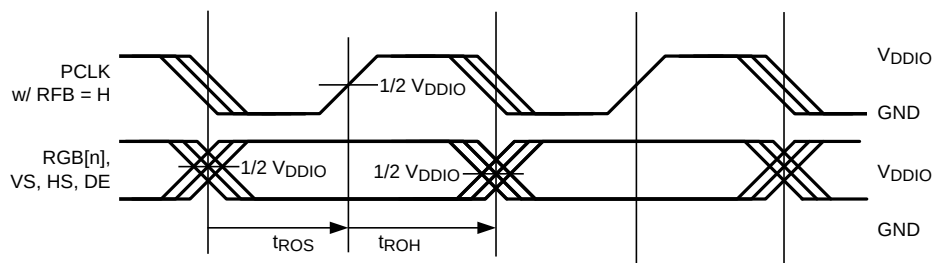
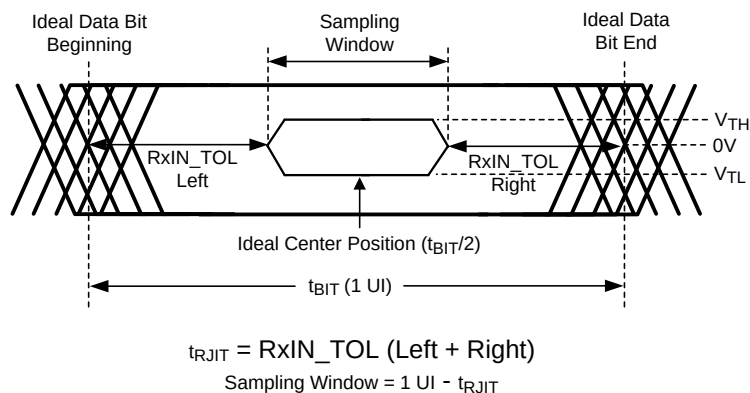
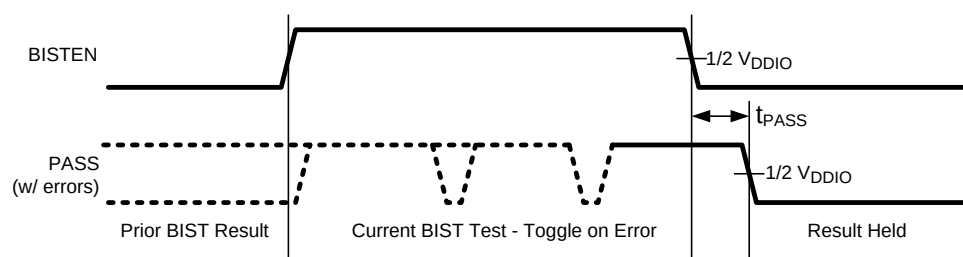
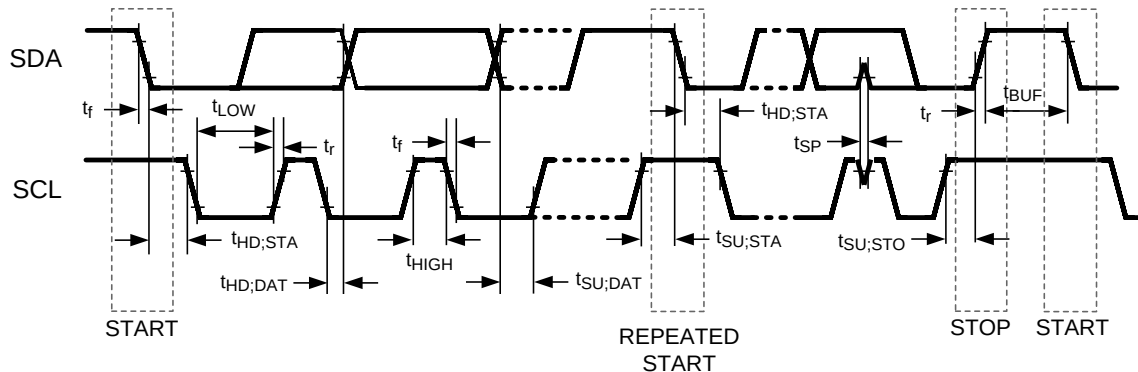


Figure 10. Deserializer Output Data Valid (Setup and Hold) Times with SSCG = On

**Figure 11. Receiver Input Jitter Tolerance****Figure 12. BIST PASS Waveform****Figure 13. Serial Control Bus Timing Diagram**

## FUNCTIONAL DESCRIPTION

The DS90UR905 / DS90UR916Q chipset transmits and receives 27-bits of data (24-high speed color bits and 3 low speed video control signals) over a single serial FPD-Link II pair operating at 140Mbps to 1.82Gbps. The serial stream also contains an embedded clock, video control signals and the DC-balance information which enhances signal quality and supports AC coupling. The pair is intended for use with each other but is backward compatible with previous generations of FPD-Link II as well.

The Des can attain lock to a data stream without the use of a separate reference clock source, which greatly simplifies system complexity and overall cost. The Des also synchronizes to the Ser regardless of the data pattern, delivering true automatic “plug and lock” performance. It can lock to the incoming serial stream without the need of special training patterns or sync characters. The Des recovers the clock and data by extracting the embedded clock information, validating and then deserializing the incoming data stream providing a parallel LVCMOS video bus to the display. White balance LUTs and dithering features are provided to enable display image enhancement.

The DS90UR905 / DS90UR916Q chipset can operate in 24-bit color depth (with VS,HS,DE encoded in the DCA bit) or in 18-bit color depth (with VS, HS, DE encoded in DCA or mapped into the high-speed data bits). In 18-bit color applications, the three video signals maybe sent encoded via the DCA bit (restrictions apply) or sent as “data bits” along with three additional general purpose signals.

### Data Transfer

The DS90UR905 / DS90UR916Q chipset will transmit and receive a pixel of data in the following format: C1 and C0 represent the embedded clock in the serial stream. C1 is always HIGH and C0 is always LOW. b[23:0] contain the scrambled RGB data. DCB is the DC-Balanced control bit. DCB is used to minimize the short and long-term DC bias on the signal lines. This bit determines if the data is unmodified or inverted. DCA is used to validate data integrity in the embedded data stream and can also contain encoded control (VS,HS,DE). Both DCA and DCB coding schemes are generated by the Ser and decoded by the Des automatically. [Figure 14](#) illustrates the serial stream per PCLK cycle.

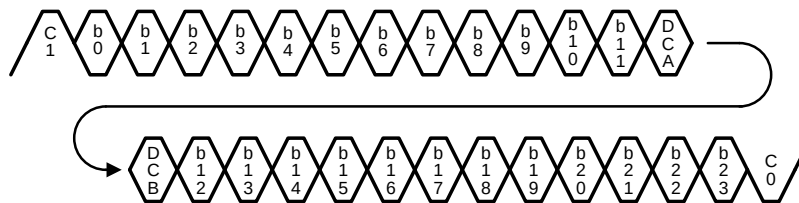


**Figure 14. FPD-Link II Serial Stream (905/916)**

### Des OPERATING MODES AND BACKWARD COMPATIBILITY (CONFIG[1:0])

The DS90UR916Q is also backward compatible with previous generations of FPD-Link II. Configuration modes are provided for backwards compatibility with the DS90C124 FPD-Link II Generation 1, and also the DS90UR124 FPD-Link II Generation 2 chipset by setting the respective mode with the CONFIG[1:0] pins or control register as shown in [Table 1](#). The selection also determines whether the Video Control Signal filter feature is enabled or disabled in Normal mode.

When the DS90UR916 deserializer is configured to operate in backward compatible modes the image enhancement features (white balance and FRC dithering) are **not** available.

**Table 1. DS90UR916Q Des Modes**

| CONFIG1 | CONFIG0 | Mode                                        | Des Device |
|---------|---------|---------------------------------------------|------------|
| L       | L       | Normal Mode, Control Signal Filter disabled | DS90UR905  |
| L       | H       | Normal Mode, Control Signal Filter enabled  | DS90UR905  |
| H       | L       | Backwards Compatible GEN2                   | DS90UR241  |
| H       | H       | Backwards Compatible GEN1                   | DS90C241   |

## Video Control Signal Filter

When operating the devices in Normal Mode, the Video Control Signals (DE, HS, VS) have the following restrictions:

- Normal Mode with Control Signal Filter Enabled:
  - DE and HS — Only 2 transitions per 130 clock cycles are transmitted, the transition pulse must be 3 PCLK or longer.
- Normal Mode with Control Signal Filter Disabled:
  - DE and HS — Only 2 transitions per 130 clock cycles are transmitted, no restriction on minimum transition pulse.
- VS — Only 1 transition per 130 clock cycles are transmitted, minimum pulse width is 130 clock cycles.

Video Control Signals are defined as low frequency signals with limited transitions. Glitches of a control signal can cause a visual display error. This feature allows for the chipset to validate and filter out any high frequency noise on the control signals. See [Figure 15](#).

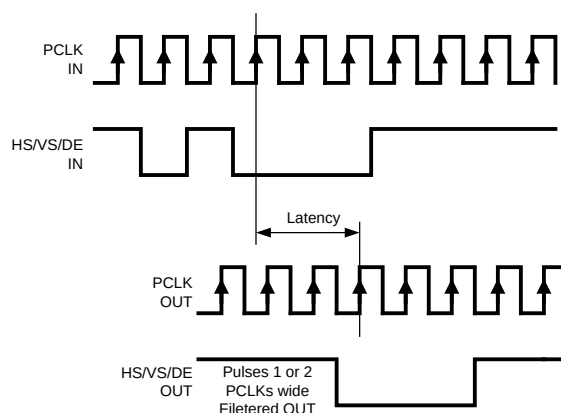


**Figure 15. Video Control Signal Filter Waveform**

## DESERIALIZER Functional Description

The Des converts a single input serial data stream to a wide parallel output bus, and also provides a signal check for the chipset Built In Self Test (BIST) mode. Several image enhancement features are provided (Note that these features are not available when operating in backward compatible modes). White balance LUTs allow the user to define and target the color temperature of the display. Adaptive Hi-FRC dithering enables the presentation of “true-color” images on an 18-bit color display. The device can be configured via external pins and strap pins or through the optional serial control bus. The Des features enhance signal quality on the link by supporting: an equalizer input and also the FPD-Link II data coding that provides randomization, scrambling, and DC balancing of the data. The Des includes multiple features to reduce EMI associated with display data transmission. This includes the randomization and scrambling of the data and also the output spread spectrum clock generation (SSCG) support. The Des features power saving features with a power down mode, and optional LVCMOS (1.8 V) interface compatibility.

## Image Enhancement Features

### White Balance

The White Balance feature enables similar display appearance when using LCD's from different vendors. It compensates for native color temperature of the display, and adjusts relative intensities of R, G, B to maintain specified color temperature. Programmable control registers are used to define the contents of three LUTs (8-bit color value for Red, Green and Blue) for the White Balance Feature. The LUTs map input RGB values to new output RGB values. There are three LUTs, one LUT for each color. Each LUT contains 256 entries, 8-bits per entry with a total size of 6144 bits (3 x 256 x 8). All entries are readable and writable. Calibrated values are loaded into registers through the I2C interface (deserializer is a slave device). This feature may also be applied to lower color depth applications such as 18-bit (666) and 16-bit (565). White balance is enabled and configured via serial bus register control.

**LUT contents.** The user must define and load the contents of the LUT for each color (R,G,B). Regardless of the color depth being driven (888, 666, 656), the user must always provide contents for 3 complete LUTs - 256 colors x 8 bits x 3 tables. Unused bits - LSBs - shall be set to "0" by the user.

When 24-bit (888) input data is being driven to a 24-bit display, each LUT (R, G and B) must contain 256 unique 8-bit entries. The 8-bit white balanced data is then available at the output of the DS90UR916 deserializer, and driven to the display.

When 18-bit (666) input data is being driven to an 18-bit display, the white balance feature may be used in one of two ways. First, simply load each LUT with 256, 8-bit entries. Each 8-bit entry is a 6-bit value (6 MSBs) with the 2 LSBs set to "00". Thus a total of 64 unique 6-bit white balance output values are available for each color (R, G and B). The 6-bit white balanced data is available at the output of the DS90UR916 deserializer, and driven directly to the display.

Alternatively, with 6-bit input data the user may choose to load complete 8-bit values into each LUT. This mode of operation provides the user with finer resolution at the LUT output to more closely achieve the desired white point of the calibrated display. Although 8-bit data is loaded, only 64 unique 8-bit white balance output values are available for each color (R, G and B). The result is 8-bit white balanced data. Before driving to the output of the deserializer, the 8-bit data must be reduced to 6-bit with an FRC dithering function. To operate in this mode, the user must configure the DS90UR916 to enable the FRC2 function.

Examples of the three types of LUT configurations described are shown in [Figure 16](#).

**Enabling white balance.** The user must load all 3 LUTs prior to enabling the white balance feature. The following sequence must be followed by the user.

To initialize white balance after power-on:

1. Load contents of all 3 LUTs . This requires a sequential loading of LUTs - first RED, second GREEN, third BLUE. 256, 8-bit entries must be loaded to each LUT. Page registers must be set to select each LUT.
2. Enable white balance

By default, the LUT data may not be reloaded after initialization at power-on.

An option does exist to allow LUT reloading after power-on and initial LUT loading (as described above). This option may only be used after enabling the white balance reload feature via the associated serial bus control register. In this mode the LUTs may be reloaded by the master controller via I2C. This provides the user with the flexibility to refresh LUTs periodically , or upon system requirements to change to a new set of LUT values. The host controller loads the updated LUT values via the serial bus interface. There is no need to disable the white balance feature while reloading the LUT data. Refreshing the white balance to the new set of LUT data will be seamless - no interruption of displayed data.

It is important to note that initial loading of LUT values requires that all 3 LUTs be loaded sequentially. When reloading, partial LUT updates may be made. Refer to [USING IMAGE ENHANCEMENT FEATURES](#) for a detailed description of the LUT loading and reloading procedures.

| 8-bit in / 8 bit out |                   | 6-bit in / 6 bit out |                   | 6-bit in / 8 bit out |                   |
|----------------------|-------------------|----------------------|-------------------|----------------------|-------------------|
| Gray level Entry     | Data Out (8-bits) | Gray level Entry     | Data Out (8-bits) | Gray level Entry     | Data Out (8-bits) |
| 0                    | 00000000b         | 0                    | 00000000b         | 0                    | 00000001b         |
| 1                    | 00000001b         | 1                    | N/A               | 1                    | N/A               |
| 2                    | 00000011b         | 2                    | N/A               | 2                    | N/A               |
| 3                    | 00000011b         | 3                    | N/A               | 3                    | N/A               |
| 4                    | 00000110b         | 4                    | 00000100b         | 4                    | 00000110b         |
| 5                    | 00000110b         | 5                    | N/A               | 5                    | N/A               |
| 6                    | 00000111b         | 6                    | N/A               | 6                    | N/A               |
| 7                    | 00000111b         | 7                    | N/A               | 7                    | N/A               |
| 8                    | 00001000b         | 8                    | 00001000b         | 8                    | 00001011b         |
| 9                    | 00001010b         | 9                    | N/A               | 9                    | N/A               |
| 10                   | 00001001b         | 10                   | N/A               | 10                   | N/A               |
| 11                   | 00001011b         | 11                   | N/A               | 11                   | N/A               |
| ⋮                    | ⋮                 | ⋮                    | ⋮                 | ⋮                    | ⋮                 |
| 248                  | 11111010b         | 248                  | 11111000b         | 248                  | 11111010b         |
| 249                  | 11111010b         | 249                  | N/A               | 249                  | N/A               |
| 250                  | 11111011b         | 250                  | N/A               | 250                  | N/A               |
| 251                  | 11111011b         | 251                  | N/A               | 251                  | N/A               |
| 252                  | 11111110b         | 252                  | 11111100b         | 252                  | 11111111b         |
| 253                  | 11111101b         | 253                  | N/A               | 253                  | N/A               |
| 254                  | 11111101b         | 254                  | N/A               | 254                  | N/A               |
| 255                  | 11111111b         | 255                  | N/A               | 255                  | N/A               |

Figure 16. White Balance LUT Configurations

### Adaptive Hi-FRC Dithering

The Adaptive FRC Dithering Feature delivers product-differentiating image quality. It reduces 24-bit RGB (8 bits per sub-pixel) to 18-bit RGB (6 bits per sub-pixel), smoothing color gradients, and allowing the flexibility to use lower cost 18-bit displays. FRC (Frame Rate Control) dithering is a method to emulate “missing” colors on a lower color depth LCD display by changing the pixel color slightly with every frame. FRC is achieved by controlling on and off pixels over multiple frames (Temporal). Static dithering regulates the number of on and off pixels in a small defined pixel group (Spatial). The FRC module includes both Temporal and Spatial methods and also Hi-FRC. Conventional FRC can display only 16,194,277 colors with 6-bit RGB source. “Hi-FRC” enables full (16,777,216) color on an 18-bit LCD panel. The “adaptive” FRC module also includes input pixel detection to apply specific Spatial dithering methods for smoother gray level transitions. When enabled, the lower LSBs of each RGB output are not active; only 18 bit data (6 bits per R,G and B) are driven to the display. This feature is enabled via serial bus register control.

Two FRC functional blocks are available, and may be independently enabled. FRC1 precedes the white balance LUT, and is intended to be used when 24-bit data is being driven to an 18-bit display with a white balance LUT that is calibrated for an 18-bit data source. The second FRC block, FRC2, follows the white balance block and is intended to be used when fine adjustment of color temperature is required on an 18-bit color display, or when a 24-bit source drives an 18-bit display with a white balance LUT calibrated for 24-bit source data.

For proper operation of the FRC dithering feature, the user must provide a description of the display timing control signals. The timing mode, “sync mode” (HS, VS) or “DE only” must be specified, along with the active polarity of the timing control signals. All this information is entered to DS90UR916 control registers via the serial bus interface.

Adaptive Hi-FRC dithering consists of several components. Initially, the incoming 8-bit data is expanded to 9-bit data. This allows the effective dithered result to support a total of 16.7 million colors. The incoming 9-bit data is evaluated, and one of four possible algorithms is selected. The majority of incoming data sequences are supported by the default dithering algorithm. Certain incoming data patterns (black/white pixel, full on/off sub-pixel) require special algorithms designed to eliminate visual artifacts associated with these specific gray level transitions. Three algorithms are defined to support these critical transitions.

An example of the default dithering algorithm is illustrated in Figure 17. The “1” or “0” value shown in the table describes whether the 6-bit value is increased by 1 (“1”) or left unchanged (“0”). In this case, the 3 truncated LSBs are “001”.

|                       |                                             |  |  |  |  |  |  |  |
|-----------------------|---------------------------------------------|--|--|--|--|--|--|--|
| <b>F0L0</b>           | Frame = 0, Line = 0                         |  |  |  |  |  |  |  |
| <b>PD1</b>            | Pixel Data one                              |  |  |  |  |  |  |  |
| <b>Cell Value 010</b> | R[7:2]+0, G[7:2]+1, B[7:2]+0                |  |  |  |  |  |  |  |
| <b>LSB=001</b>        | three lsb of 9 bit data (8 to 9 for Hi-Frc) |  |  |  |  |  |  |  |

| Pixel Index      | PD1 | PD2 | PD3 | PD4 | PD5 | PD6 | PD7 | PD8 |                                  |
|------------------|-----|-----|-----|-----|-----|-----|-----|-----|----------------------------------|
| <b>LSB = 001</b> |     |     |     |     |     |     |     |     |                                  |
| F0L0             | 010 | 000 | 000 | 000 | 000 | 000 | 010 | 000 | R = 4/32<br>G = 4/32<br>B = 4/32 |
| F0L1             | 101 | 000 | 000 | 000 | 101 | 000 | 000 | 000 |                                  |
| F0L2             | 000 | 000 | 010 | 000 | 010 | 000 | 000 | 000 |                                  |
| F0L3             | 000 | 000 | 101 | 000 | 000 | 000 | 101 | 000 |                                  |
| F1L0             | 000 | 000 | 000 | 000 | 000 | 000 | 000 | 000 | R = 4/32<br>G = 4/32<br>B = 4/32 |
| F1L1             | 000 | 111 | 000 | 000 | 000 | 111 | 000 | 000 |                                  |
| F1L2             | 000 | 000 | 000 | 000 | 000 | 000 | 000 | 000 |                                  |
| F1L3             | 000 | 000 | 000 | 111 | 000 | 000 | 000 | 111 |                                  |
| F2L0             | 000 | 000 | 010 | 000 | 010 | 000 | 000 | 000 | R = 4/32<br>G = 4/32<br>B = 4/32 |
| F2L1             | 000 | 000 | 101 | 000 | 000 | 000 | 101 | 000 |                                  |
| F2L2             | 010 | 000 | 000 | 000 | 000 | 000 | 010 | 000 |                                  |
| F2L3             | 101 | 000 | 000 | 000 | 101 | 000 | 000 | 000 |                                  |
| F3L0             | 000 | 000 | 000 | 000 | 000 | 000 | 000 | 000 | R = 4/32<br>G = 4/32<br>B = 4/32 |
| F3L1             | 000 | 000 | 000 | 111 | 000 | 000 | 000 | 111 |                                  |
| F3L2             | 000 | 000 | 000 | 000 | 000 | 000 | 000 | 000 |                                  |
| F3L3             | 000 | 111 | 000 | 000 | 000 | 111 | 000 | 000 |                                  |

**Figure 17. Default FRC Algorithm**

## Signal Quality Enhancers

### Des — Input Equalizer Gain (EQ)

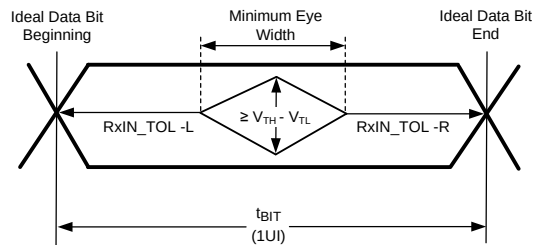
The Des can enable receiver input equalization of the serial stream to increase the eye opening to the Des input. Note this function cannot be seen at the RxIN+/- input but can be observed at the serial test port (CMLOUTP/N) enabled via the Serial Bus control registers. The equalization feature may be controlled by the external pin or by register.

**Table 2. Receiver Equalization Configuration Table**

| INPUTS |     |     |     | Effect   |
|--------|-----|-----|-----|----------|
| EQ3    | EQ2 | EQ1 | EQ0 |          |
| L      | L   | L   | H   | ~1.5 dB  |
| L      | L   | H   | H   | ~3 dB    |
| L      | H   | L   | H   | ~4.5 dB  |
| L      | H   | H   | H   | ~6 dB    |
| H      | L   | L   | H   | ~7.5 dB  |
| H      | L   | H   | H   | ~9 dB    |
| H      | H   | L   | H   | ~10.5 dB |
| H      | H   | H   | H   | ~12 dB   |
| X      | X   | X   | L   | OFF*     |

\* Default Setting is EQ = Off

The quality of the equalized signal may be assessed by monitoring the differential eye opening at the CMLOUTP/N. The Receiver Differential Input Threshold and Input Jitter Tolerance define the acceptable data eye opening. A differential probe should be used to measure across a 100Ohm termination resistor between the CMLOUTP/N pins. [Figure 18](#) illustrates the eye opening.

**Figure 18. CMLOUT Eye Opening**

### EMI Reduction Features

#### Output Slew (OS\_PCLK/DATA)

The parallel bus outputs (RGB[7:0], VS, HS, DE and PCLK) of the Des feature a selectable output slew. The DATA ((RGB[7:0], VS, HS, DE) are controlled by strap pin or register bit OS\_DATA. The PCLK is controlled by strap pin or register bit OS\_PCLK. When the OS\_PCLK/DATA = HIGH, the maximum slew rate is selected. When the OS\_PCLK/DATA = LOW, the minimum slew rate is selected. Use the higher slew rate setting when driving longer traces or a heavier capacitive load.

#### Common Mode Filter Pin (CMF) — Optional

The Des provides access to the center tap of the internal termination. A capacitor may be placed on this pin for additional common-mode filtering of the differential pair. This can be useful in high noise environments for additional noise rejection capability. A 0.1μF capacitor may be connected to this pin to Ground.

#### SSCG Generation — Optional

The Des provides an internally generated spread spectrum clock (SSCG) to modulate its outputs. Both clock and data outputs are modulated. This will aid to lower system EMI. Output SSCG deviations to ±2.0% (4% total) at up to 35kHz modulations nominally are available. See [Table 3](#). This feature may be controlled by external STRAP pins or by register.

**Table 3. SSCG Configuration (LF\_MODE = L) — Des Output**

| SSC[3:0] Inputs<br>LF_MODE = L (20 - 65 MHz) |      |      |      | Result   |            |
|----------------------------------------------|------|------|------|----------|------------|
| SSC3                                         | SSC2 | SSC1 | SSC0 | fdev (%) | fmod (kHz) |
| L                                            | L    | L    | L    | Off      | Off        |
| L                                            | L    | L    | H    | ±0.5     | PCLK/2168  |
| L                                            | L    | H    | L    | ±1.0     |            |
| L                                            | L    | H    | H    | ±1.5     |            |
| L                                            | H    | L    | L    | ±2.0     |            |
| L                                            | H    | L    | H    | ±0.5     | PCLK/1300  |
| L                                            | H    | H    | L    | ±1.0     |            |
| L                                            | H    | H    | H    | ±1.5     |            |
| H                                            | L    | L    | L    | ±2.0     |            |
| H                                            | L    | L    | H    | ±0.5     | PCLK/868   |
| H                                            | L    | H    | L    | ±1.0     |            |
| H                                            | L    | H    | H    | ±1.5     |            |
| H                                            | H    | L    | L    | ±2.0     |            |
| H                                            | H    | L    | H    | ±0.5     | PCLK/650   |
| H                                            | H    | H    | L    | ±1.0     |            |
| H                                            | H    | H    | H    | ±1.5     |            |

**Table 4. SSCG Configuration (LF\_MODE = H) — Des Output**

| SSC[3:0] Inputs<br>LH_MODE = H (5 - 20 MHz) |      |      |      | Result   |            |
|---------------------------------------------|------|------|------|----------|------------|
| SSC3                                        | SSC2 | SSC1 | SSC0 | fdev (%) | fmod (kHz) |
| L                                           | L    | L    | L    | Off      | Off        |
| L                                           | L    | L    | H    | ±0.5     | PCLK/620   |
| L                                           | L    | H    | L    | ±1.0     |            |
| L                                           | L    | H    | H    | ±1.5     |            |
| L                                           | H    | L    | L    | ±2.0     |            |
| L                                           | H    | L    | H    | ±0.5     | PCLK/370   |
| L                                           | H    | H    | L    | ±1.0     |            |
| L                                           | H    | H    | H    | ±1.5     |            |
| H                                           | L    | L    | L    | ±2.0     |            |
| H                                           | L    | L    | H    | ±0.5     | PCLK/258   |
| H                                           | L    | H    | L    | ±1.0     |            |
| H                                           | L    | H    | H    | ±1.5     |            |
| H                                           | H    | L    | L    | ±2.0     |            |
| H                                           | H    | L    | H    | ±0.5     | PCLK/192   |
| H                                           | H    | H    | L    | ±1.0     |            |
| H                                           | H    | H    | H    | ±1.5     |            |

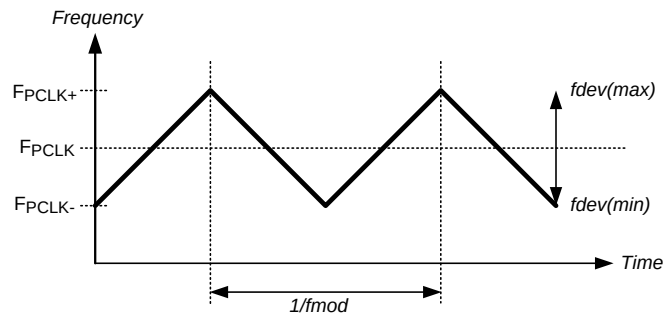


Figure 19. SSCG Waveform

### 1.8V or 3.3V VDDIO Operation

The Des parallel bus and Serial Bus Interface can operate with 1.8 V or 3.3 V levels ( $V_{DDIO}$ ) for target (Display) compatibility. The 1.8 V levels will offer a lower noise (EMI) and also a system power savings.

### Power Saving Features

#### PowerDown Feature (PDB)

The Des has a PDB input pin to ENABLE or POWER DOWN the device. This pin can be controlled by the system to save power, disabling the Des when the display is not needed. An auto detect mode is also available. In this mode, the PDB pin is tied High and the Des will enter POWER DOWN when the serial stream stops. When the serial stream starts up again, the Des will lock to the input stream and assert the LOCK pin and output valid data. In POWER DOWN mode, the Data and PCLK output states are determined by the OSS\_SEL status. Note – in POWER DOWN, the optional Serial Bus Control Registers are **RESET**.

#### Stop Stream SLEEP Feature

The Des will enter a low power SLEEP state when the input serial stream is stopped. A STOP condition is detected when the embedded clock bits are not present. When the serial stream starts again, the Des will then lock to the incoming signal and recover the data. Note – in STOP STREAM SLEEP, the optional Serial Bus Control Registers values are **RETAINED**.

### CLOCK-DATA RECOVERY STATUS FLAG (LOCK) and OUTPUT STATE SELECT (OSS\_SEL)

When PDB is driven HIGH, the CDR PLL begins locking to the serial input and LOCK goes from TRI-STATE to LOW (depending on the value of the OSS\_SEL setting). After the DS90UR916Q completes its lock sequence to the input serial data, the LOCK output is driven HIGH, indicating valid data and clock recovered from the serial input is available on the parallel bus and PCLK outputs. The PCLK output is held at its current state at the change from OSC\_CLK (if this is enabled via OSC\_SEL) to the recovered clock (or vice versa).

If there is a loss of clock from the input serial stream, LOCK is driven Low and the state of the RGB/VS/HS/DE outputs are based on the OSS\_SEL setting (STRAP PIN configuration or register).

### Oscillator Output — Optional

The Des provides an optional PCLK output when the input clock (serial stream) has been lost. This is based on an internal oscillator. The frequency of the oscillator may be selected. This feature may be controlled by the external pin or by register. See [Table 6](#) and [Table 7](#).

**Table 5. OSS\_SEL and PDB Configuration — Des Outputs<sup>(1)</sup>**

| INPUTS       |     |         | OUTPUTS |              |      |      |
|--------------|-----|---------|---------|--------------|------|------|
| Serial Input | PDB | OSS_SEL | PCLK    | RGB/HS/VS/DE | LOCK | PASS |
| X            | L   | X       | Z       | Z            | Z    | Z    |
| Static       | H   | L       | L       | L            | L    | L    |
| Static       | H   | H       | Z       | Z*           | L    | L    |
| Active       | H   | X       | Active  | Active       | H    | H    |

(1) If pin is strapped HIGH, output will be pulled up

**Table 6. OSC (Oscillator) Mode — Des Output**

| INPUTS             | OUTPUTS    |              |      |      |
|--------------------|------------|--------------|------|------|
| Embedded PCLK      | PCLK       | RGB/HS/VS/DE | LOCK | PASS |
| See <sup>(1)</sup> | OSC Output | L            | L    | L    |
| Present            | Toggling   | Active       | H    | H    |

(1) Absent and OSS\_SEL ≠ 000

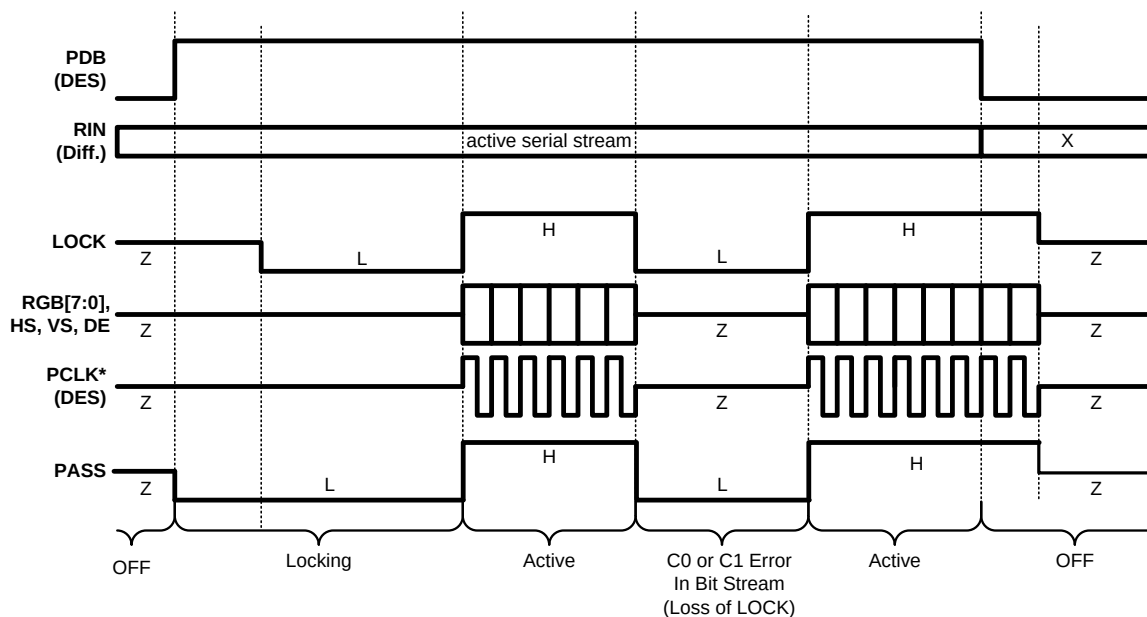


**Figure 20. Des Outputs with Output State Select Low (OSS\_SEL = H)**

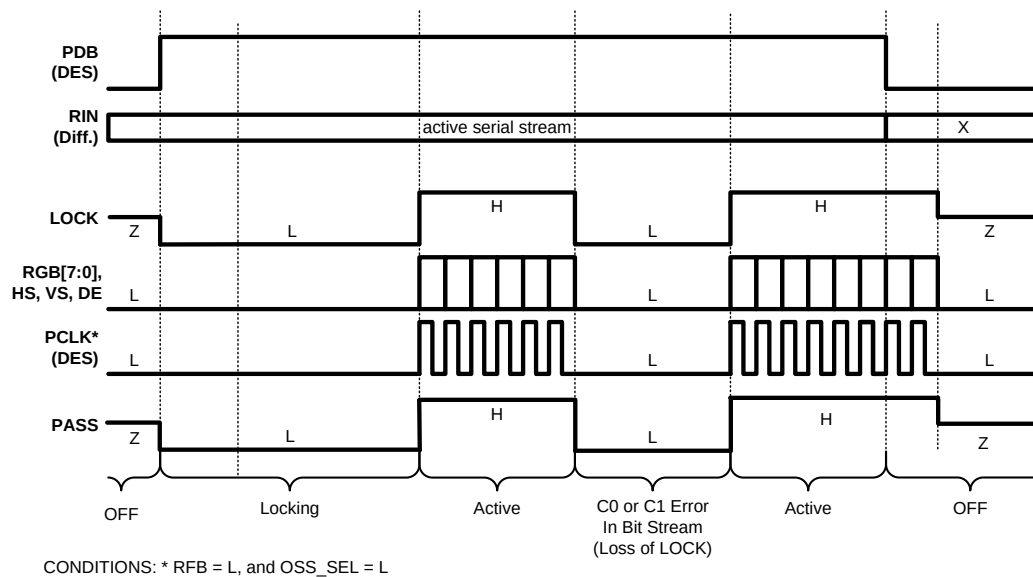


Figure 21. Des Outputs with Output State Select High (OSS\_SEL = L)

Table 7. OSC\_SEL (Oscillator) Configuration

| OSC_SEL[2:0] INPUTS |          |          | PCLK Oscillator Output           |
|---------------------|----------|----------|----------------------------------|
| OSC_SEL2            | OSC_SEL1 | OSC_SEL0 |                                  |
| L                   | L        | L        | Off – Feature Disabled – Default |
| L                   | L        | H        | 50 MHz $\pm 40\%$                |
| L                   | H        | L        | 25 MHz $\pm 40\%$                |
| L                   | H        | H        | 16.7 MHz $\pm 40\%$              |
| H                   | L        | L        | 12.5 MHz $\pm 40\%$              |
| H                   | L        | H        | 10 MHz $\pm 40\%$                |
| H                   | H        | L        | 8.3 MHz $\pm 40\%$               |
| H                   | H        | H        | 6.3 MHz $\pm 40\%$               |

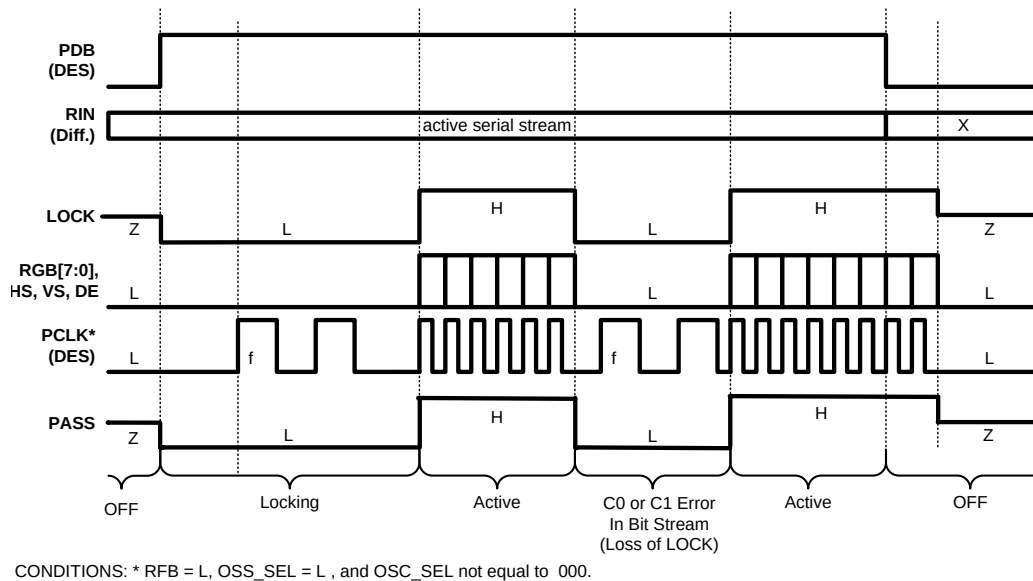


Figure 22. Des Outputs with Output State High and PCLK Output Oscillator Option Enabled

### OP\_LOW — Optional

The OP\_LOW feature is used to hold the LVCMOS outputs (except the LOCK output) at a LOW state. This feature is enabled by setting the OP\_LOW strap pin = HIGH, followed by the rising edge of PDB. The user must toggle the OP\_LOW Set/Reset register bit to release the outputs to the normal toggling state. Note that the release of the outputs can only occur when LOCK is HIGH. When the OP\_LOW feature is enabled, anytime LOCK = LOW, the LVCMOS outputs will toggle to a LOW state again. The OP\_LOW strap pin feature is assigned to output PASS pin 42.

Restrictions on other straps:

- 1) Other straps should not be used in order to keep RGB[7:0], HS, VS, DE, and PCLK at a true LOW state. Other features should be selected thru I2C.
- 2) OSS\_SEL function is not available when O/P\_LOW is tied H.

Outputs RGB[7:0], HSYNC, VSYNC, DE, and PCLK are in TRI-STATE before PDB toggles HIGH because the OP\_LOW strap value has not been recognized until the DS90UR916 powers up. Figure 23 shows the user controlled release of OP\_LOW and automatic reset of OP\_LOW set on the falling edge of LOCK. Figure 24 shows the user controlled release of OP\_LOW and manual reset of OP\_LOW set. Note manual reset of OP\_LOW can only occur when LOCK is H.

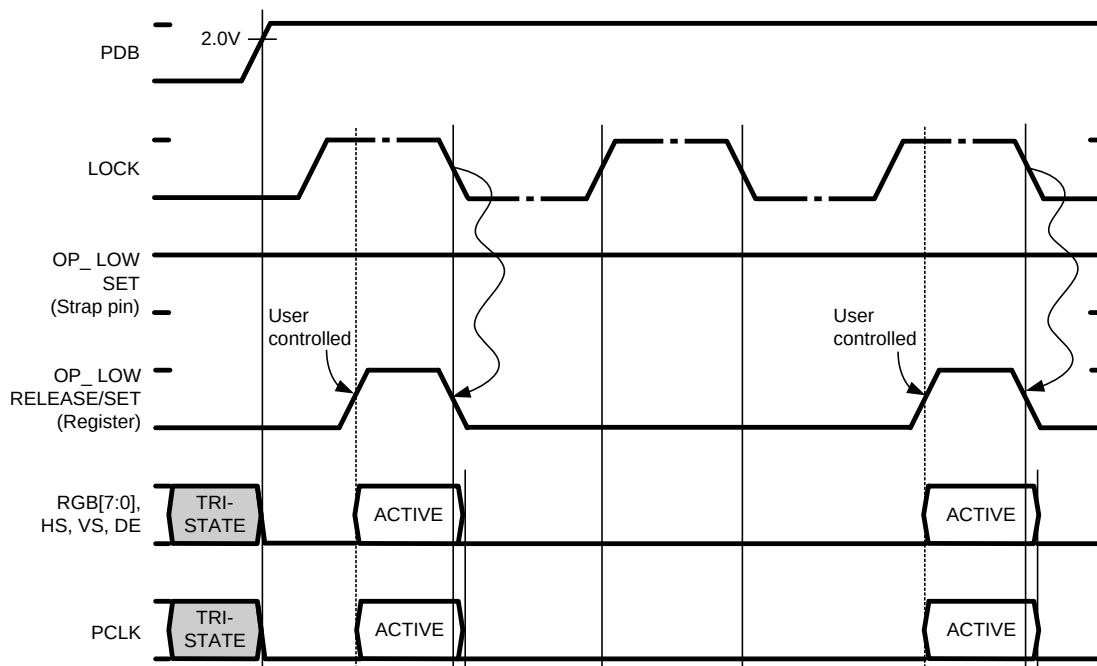


Figure 23. OP\_LOW Auto Set

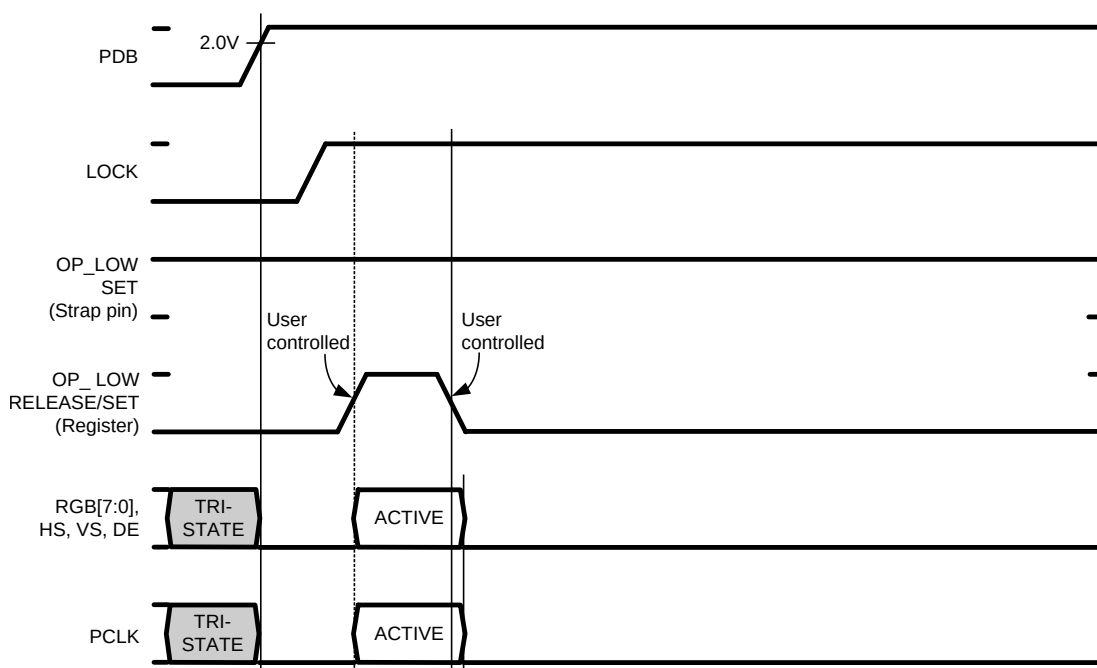


Figure 24. OP\_LOW Manual Set/Reset

### Pixel Clock Edge Select (RFB)

The RFB pin determines the edge that the data is strobed on. If RFB is High, output data is strobed on the Rising edge of the PCLK. If RFB is Low, data is strobed on the Falling edge of the PCLK. This allows for interoperability with downstream devices. The Des output does not need to use the same edge as the Ser input. This feature may be controlled by the external pin or by register.

### Control Signal Filter — Optional

The Des provides an optional Control Signal (VS, HS, DE) filter that monitors the three video control signals and eliminates any pulses that are 1 or 2 PCLKs wide. Control signals must be 3 pixel clocks wide (in its HIGH or LOW state, regardless of which state is active). This is set by the CONFIG[1:0] or by the Control Register. This feature may be controlled by the external pin or by Register.

### Low Frequency Optimization (LF\_Mode)

This feature may be controlled by the external pin or by Register.

### Des — Map Select

This feature may be controlled by the external pin or by Register.

**Table 8. Map Select Configuration**

| INPUTS  |         | Effect                                |
|---------|---------|---------------------------------------|
| MAPSEL1 | MAPSEL0 |                                       |
| L       | L       | Bit 4, Bit 5 on LSB<br><b>DEFAULT</b> |
| L       | H       | LSB 0 or 1                            |
| H       | H or L  | LSB 0                                 |

### Strap Input Pins

Configuration of the device maybe done via configuration input pins and the STRAP input pins, or via the Serial Control Bus. The STRAP input pins share select parallel bus output pins. They are used to load in configuration values during the initial power up sequence of the device. Only a pull-up on the pin is required when a HIGH is desired. By default the pad has an internal pull down, and will bias Low by itself. The recommended value of the pull up is 10 kΩ to V<sub>DDIO</sub>; open (NC) for Low, no pull-down is required (internal pull-down). If using the Serial Control Bus, no pull ups are required.

### Optional Serial Bus Control

Please see the following section on the optional Serial Bus Control Interface.

### Optional BIST Mode

Please see the following section on the chipset BIST mode for details.

### Built In Self Test (BIST)

An optional At-Speed Built In Self Test (BIST) feature supports the testing of the high-speed serial link. This is useful in the prototype stage, equipment production, in-system test and also for system diagnostics. In the BIST mode only a input clock is required along with control to the Ser and Des BISTEN input pins. The Ser outputs a test pattern (PRBS7) and drives the link at speed. The Des detects the PRBS7 pattern and monitors it for errors. A PASS output pin toggles to flag any payloads that are received with 1 to 24 errors. Upon completion of the test, the result of the test is held on the PASS output until reset (new BIST test or Power Down). A high on PASS indicates NO ERRORS were detected. A Low on PASS indicates one or more errors were detected. The duration of the test is controlled by the pulse width applied to the Des BISTEN pin. During the BIST duration the deserializer data outputs toggle with a checkerboard pattern.

Inter-operability is supported between this FPD-Link II device and all FPD-Link II generations (Gen 1/2/3) — see respective datasheets for details on entering BIST mode and control.

### Sample BIST Sequence

See [Figure 25](#) for the BIST mode flow diagram.

**Step 1:** Place the DS90UR905 Ser in BIST Mode by setting Ser BISTEN = H. For the DS90UR905 Ser or DS99R421 FPD-Link II Ser BIST Mode is enabled via the BISTEN pin. For the DS90C241 Ser or DS90UR241 Ser, BIST mode is entered by setting all the input data of the device to Low state. A PCLK is required for all the Ser options. When the Des detects the BIST mode pattern and command (DCA and DCB code) the RGB and control signal outputs are shut off.

**Step 2:** Place the DS90UR916Q Des in BIST mode by setting the BISTEN = H. The Des is now in the BIST mode and checks the incoming serial payloads for errors. If an error in the payload (1 to 24) is detected, the PASS pin will switch low for one half of the clock period. During the BIST test, the PASS output can be monitored and counted to determine the payload error rate.

**Step 3:** To Stop the BIST mode, the Des BISTEN pin is set Low. The Des stops checking the data and the final test result is held on the PASS pin. If the test ran error free, the PASS output will be High. If there was one or more errors detected, the PASS output will be Low. The PASS output state is held until a new BIST is run, the device is RESET, or Powered Down. The BIST duration is user controlled by the duration of the BISTEN signal.

**Step 4:** To return the link to normal operation, the Ser BISTEN input is set Low. The Link returns to normal operation.

Figure 26 shows the waveform diagram of a typical BIST test for two cases. Case 1 is error free, and Case 2 shows one with multiple errors. In most cases it is difficult to generate errors due to the robustness of the link (differential data transmission etc.), thus they may be introduced by greatly extending the cable length, faulting the interconnect, reducing signal condition enhancements (De-Emphasis, VODSEL, or Rx Equalization).

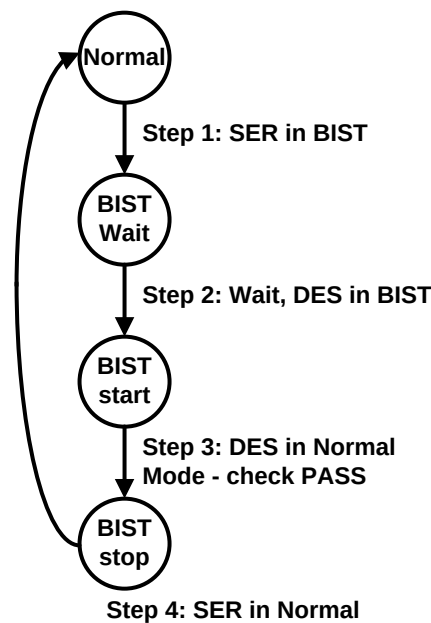


**Figure 25. BIST Mode Flow Diagram**

## BER Calculations

It is possible to calculate the approximate Bit Error Rate (BER). The following is required:

- Pixel Clock Frequency (MHz)
- BIST Duration (seconds)
- BIST test Result (PASS)

The BER is less than or equal to one over the product of 24 times the PCLK rate times the test duration. If we assume a 65MHz PCLK, a 10 minute (600 second) test, and a PASS, the BERT is  $\leq 1.07 \times 10^{-12}$

The BIST mode runs a check on the data payload bits. The LOCK pin also provides a link status. If the recovery of the C0 and C1 bits does not reconstruct the expected clock signal, the LOCK pin will switch Low. The combination of the LOCK and At-Speed BIST PASS pin provides a powerful tool for system evaluation and performance monitoring.

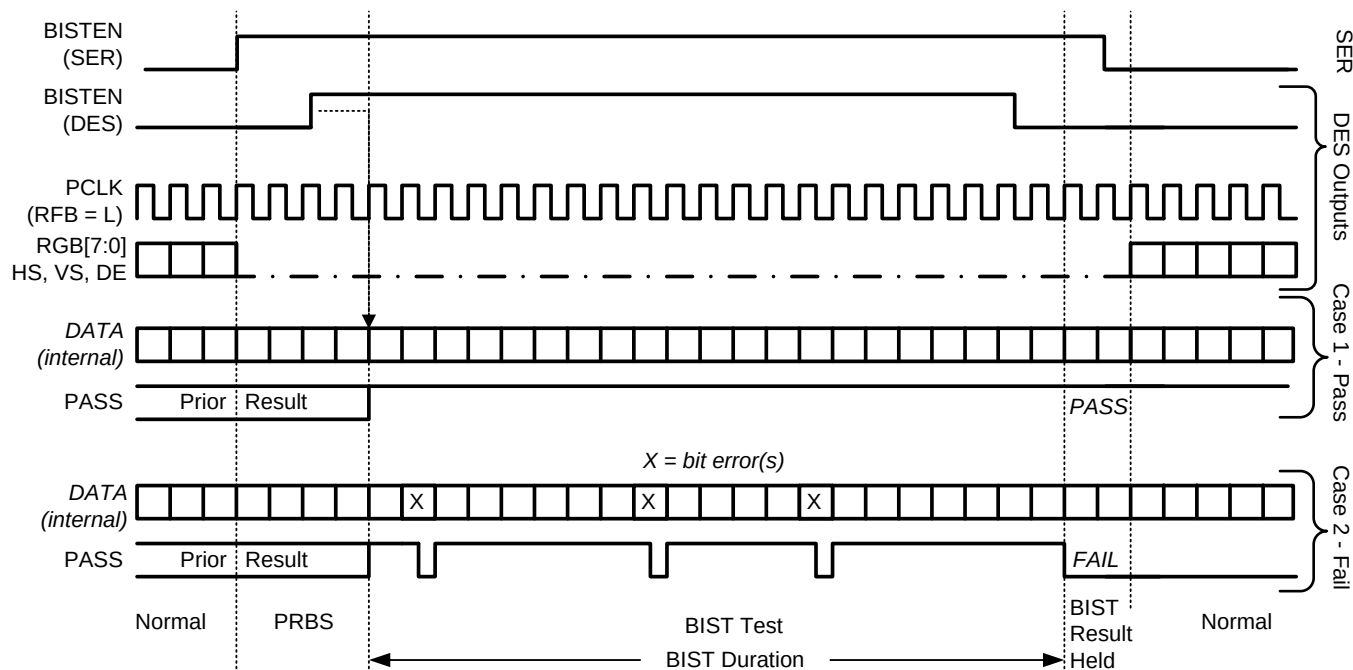


Figure 26. BIST Waveforms

## Optional Serial Bus Control

The DS90UR916 may also be configured by the use of a serial control bus that is I2C protocol compatible. By default, the I2C reg\_0x00'h is set to 00'h and all configuration is set by control/strap pins. A write of 01'h to reg\_0x00'h will enable/allow configuration by registers; this will override the control/strap pins. Multiple devices may share the serial control bus since multiple addresses are supported. See Figure 27.

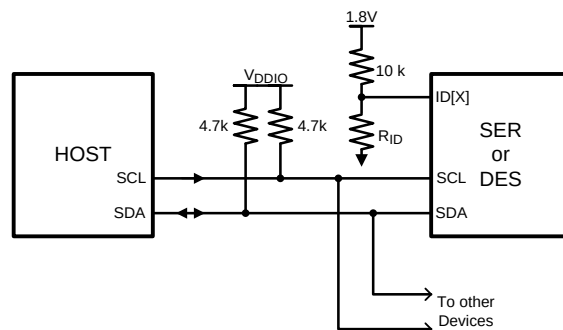


Figure 27. Serial Control Bus Connection

The serial bus is comprised of three pins. The SCL is a Serial Bus Clock Input. The SDA is the Serial Bus Data Input / Output signal. Both SCL and SDA signals require an external pull up resistor to  $V_{DDIO}$ . For most applications a 4.7 k pull up resistor to  $V_{DDIO}$  may be used. The resistor value may be adjusted for capacitive loading and data rate requirements. The signals are either pulled High, or driven Low.

The third pin is the ID[X] pin. This pin sets one of four possible device addresses. Two different connections are possible. The pin may be pulled to  $V_{DD}$  (1.8V, NOT  $V_{DDIO}$ ) with a 10 k $\Omega$  resistor; or a 10 k $\Omega$  pull up resistor (to  $V_{DD}$  1.8V, NOT  $V_{DDIO}$ ) and a pull down resistor of the recommended value to set other three possible addresses may be used. See Table 9. Do not tie ID[x] directly to VSS.

The Serial Bus protocol is controlled by START, START-Repeated, and STOP phases. A START occurs when SCL transitions Low while SDA is High. A STOP occurs when SDA transition High while SCL is also HIGH. See Figure 28.

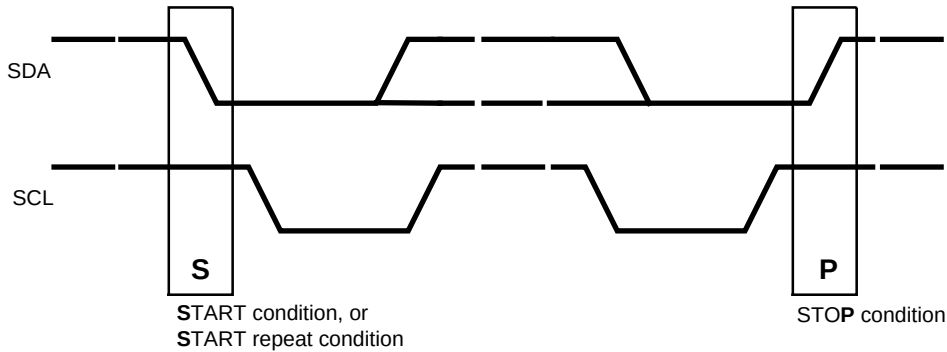


**Figure 28. START and STOP Conditions**

To communicate with a remote device, the host controller (master) sends the slave address and listens for a response from the slave. This response is referred to as an acknowledge bit (ACK). If a slave on the bus is addressed correctly, it Acknowledges (ACKs) the master by driving the SDA bus low. If the address doesn't match a device's slave address, it Not-acknowledges (NACKs) the master by letting SDA be pulled High. ACKs also occur on the bus when data is being transmitted. When the master is writing data, the slave ACKs after every data byte is successfully received. When the master is reading data, the master ACKs after every data byte is received to let the slave know it wants to receive another data byte. When the master wants to stop reading, it NACKs after the last data byte and creates a stop condition on the bus. All communication on the bus begins with either a Start condition or a Repeated Start condition. All communication on the bus ends with a Stop condition. A READ is shown in [Figure 29](#) and a WRITE is shown in [Figure 30](#).

If the Serial Bus is not required, the three pins may be left open (NC).

**Table 9. ID[x] Resistor Value – DS90UR916Q Des**

| Resistor<br>RID* kΩ (5% tol) | Address<br>7'b      | Address<br>8'b<br>0 appended<br>(WRITE) |
|------------------------------|---------------------|-----------------------------------------|
| 0.47                         | 7b' 111 0001 (h'71) | 8b' 1110 0010 (h'E2)                    |
| 2.7                          | 7b' 111 0010 (h'72) | 8b' 1110 0100 (h'E4)                    |
| 8.2                          | 7b' 111 0011 (h'73) | 8b' 1110 0110 (h'E6)                    |
| Open                         | 7b' 111 0110 (h'76) | 8b' 1110 1100 (h'EC)                    |

\*Note: RID ≠ 0 ohm, do not connect directly to VSS (GND), this is not a valid address.

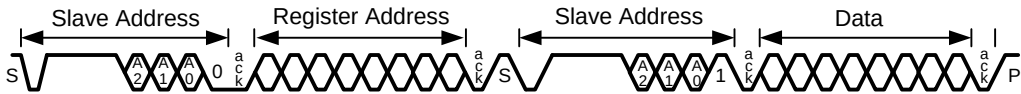


**Figure 29. Serial Control Bus — READ**

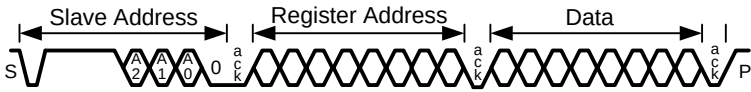


**Figure 30. Serial Control Bus — WRITE**

**Table 10. DESERIALIZER — Serial Bus Control Registers**

| PAGE | ADD (dec) | ADD (hex) | Register Name  | Bit(s) | R/W | Default (bin) | Function            | Description                                                                                                                                                                      |
|------|-----------|-----------|----------------|--------|-----|---------------|---------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 0    | 0         | 0         | Des Config 1   | 7      | R/W | 0             | LFMODE              | 0: 20 to 65 MHz Operation<br>1: 5 to 20 MHz Operation                                                                                                                            |
|      |           |           |                | 6      | R/W | 0             | OS_PCLK             | 0: Normal PCLK Output Slew<br>1: Increased PCLK Slew                                                                                                                             |
|      |           |           |                | 5      | R/W | 0             | OS_DATA             | 0: Normal DATA OUTPUT Slew<br>1: Increased Data Slew                                                                                                                             |
|      |           |           |                | 4      | R/W | 0             | RFB                 | 0: Data strobed on Falling edge of PCLK<br>1: Data strobed on Rising edge of PCLK                                                                                                |
|      |           |           |                | 3:2    | R/W | 00            | CONFIG              | 00: Normal Mode, Control Signal Filter Disabled<br>01: Normal Mode, Control Signal Filter Enabled<br>10: Backwards Compatible (DS90UR241)<br>11: Backwards Compatible (DS90C241) |
|      |           |           |                | 1      | R/W | 0             | SLEEP               | Note – not the same function as PowerDown (PDB)<br>0: normal mode<br>1: Sleep Mode – <b>Register settings retained.</b>                                                          |
|      |           |           |                | 0      | R/W | 0             | REG Control         | 0: Configurations set from control pins / STRAP pins<br>1: Configurations set from registers (except I2C_ID)                                                                     |
| 0    | 1         | 1         | Slave ID       | 7      | R/W | 0             |                     | 0: Address from ID[X] Pin<br>1: Address from Register                                                                                                                            |
|      |           |           |                | 6:0    | R/W | 1110000       | ID[X]               | Serial Bus Device ID, Four IDs are:<br>7b '1110 001 (h'71)<br>7b '1110 010 (h'72)<br>7b '1110 011 (h'73)<br>7b '1110 110 (h'76)<br>All other addresses are <b>Reserved</b> .     |
| 0    | 2         | 2         | Des Features 1 | 7      | R/W | 0             | OP_LOW Release/Set  | 0: set outputs state LOW (except LOCK)<br>1: release output LOW state, outputs toggling normally<br>Note: This register only works during LOCK = 1.                              |
|      |           |           |                | 6      | R/W | 0             | OSS_SEL             | Output Sleep State Select<br>0:PCLK/RGB[7:0]/HS/VS/DE = L, LOCK = Normal, PASS = H<br>1:PCLK/RGB[7:0]/HS/VS/DE = Tri-State, LOCK = Normal, PASS = H                              |
|      |           |           |                | 5:4    | R/W | 00            | MAP_SEL             | Special for Backwards Compatible Mode with DS90UR241)<br>00: bit 4, 5 on LSB<br>01: LSB zero or one<br>10: LSB zero<br>11: LSB zero                                              |
|      |           |           |                | 3      | R/W | 0             | OP_LOW strap bypass | 0: strap will determine whether OP_LOW feature is ON or OFF<br>1: Turns OFF OP_LOW feature                                                                                       |
|      |           |           |                | 2:0    | R/W | 00            | OSC_SEL             | 000: OFF<br>001: 50 MHz ±40%<br>010: 25 MHz ±40%<br>011: 16.7 MHz ±40%<br>100: 12.5 MHz ±40%<br>101: 10 MHz ±40%<br>110: 8.3 MHz ±40%<br>111: 6.3 MHz ±40%                       |

**Table 10. DESERIALIZER — Serial Bus Control Registers (continued)**

| PAGE | ADD (dec) | ADD (hex) | Register Name     | Bit(s) | R/W | Default (bin) | Function           | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
|------|-----------|-----------|-------------------|--------|-----|---------------|--------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 0    | 3         | 3         | Des Features 2    | 7:5    | R/W | 000           | EQ Gain            | 000: ~1.625 dB<br>001: ~3.25 dB<br>010: ~4.87 dB<br>011: ~6.5 dB<br>100: ~8.125 dB<br>101: ~9.75 dB<br>110: ~11.375 dB<br>111: ~13 dB                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|      |           |           |                   | 4      | R/W | 0             | EQ Enable          | 0: EQ = disabled<br>1: EQ = enabled                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
|      |           |           |                   | 3:0    | R/W | 0000          | SSC                | <b>IF LF_MODE = 0, then:</b><br>000: SSCG OFF<br>0001: fdev = ±0.5%, fmod = PCLK/2168<br>0010: fdev = ±1.0%, fmod = PCLK/2168<br>0011: fdev = ±1.5%, fmod = PCLK/2168<br>0100: fdev = ±2.0%, fmod = PCLK/2168<br>0101: fdev = ±0.5%, fmod = PCLK/1300<br>0110: fdev = ±1.0%, fmod = PCLK/1300<br>0111: fdev = ±1.5%, fmod = PCLK/1300<br>1000: fdev = ±2.0%, fmod = PCLK/1300<br>1001: fdev = ±0.5%, fmod = PCLK/868<br>1010: fdev = ±1.0%, fmod = PCLK/868<br>1011: fdev = ±1.5%, fmod = PCLK/868<br>1100: fdev = ±2.0%, fmod = PCLK/868<br>1101: fdev = ±0.5%, fmod = PCLK/650<br>1110: fdev = ±1.0%, fmod = PCLK/650<br>1111: fdev = ±1.5%, fmod = PCLK/650<br><b>IF LF_MODE = 1, then:</b><br>000: SSCG OFF<br>0001: fdev = ±0.5%, fmod = PCLK/620<br>0010: fdev = ±1.0%, fmod = PCLK/620<br>0011: fdev = ±1.5%, fmod = PCLK/620<br>0100: fdev = ±2.0%, fmod = PCLK/620<br>0101: fdev = ±0.5%, fmod = PCLK/370<br>0110: fdev = ±1.0%, fmod = PCLK/370<br>0111: fdev = ±1.5%, fmod = PCLK/370<br>1000: fdev = ±2.0%, fmod = PCLK/370<br>1001: fdev = ±0.5%, fmod = PCLK/258<br>1010: fdev = ±1.0%, fmod = PCLK/258<br>1011: fdev = ±1.5%, fmod = PCLK/258<br>1100: fdev = ±2.0%, fmod = PCLK/258<br>1101: fdev = ±0.5%, fmod = PCLK/192<br>1110: fdev = ±1.0%, fmod = PCLK/192<br>1111: fdev = ±1.5%, fmod = PCLK/192 |
| 0    | 4         | 4         | CMLOUT Config     | 7      | R/W | 0             | Repeater Enable    | 0: Output CMLOUTP/N = disabled<br>1: Output CMLOUTP/N = enabled                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
|      |           |           |                   | 6:0    | R/W | 0000000       | <b>Reserved</b>    | <b>Reserved</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| 0    | 21        | 15        | FRC Configuration | 7      | R/W | 0             | Timing mode select | Select display timing mode<br>0: DE only mode<br>1: Sync mode (VS, HS)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
|      |           |           |                   | 6      | R/W | 0             | VS Polarity        | 0: Active HIGH<br>1: Active LOW                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
|      |           |           |                   | 5      | R/W | 0             | HS Polarity        | 0: Active HIGH<br>1: Active LOW                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
|      |           |           |                   | 4      | R/W | 0             | DE Polarity        | 0: Active HIGH<br>1: Active LOW                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
|      |           |           |                   | 3      | R/W | 0             | FRC2 enable        | 0: FRC2 disabled<br>1: FRC2 enabled                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
|      |           |           |                   | 2      | R/W | 0             | FRC1 enable        | 0: FRC1 disabled<br>1: FRC1 enabled                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
|      |           |           |                   | [1:0]  |     | 0             | <b>Reserved</b>    | <b>Reserved</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |

**Table 10. DESERIALIZER — Serial Bus Control Registers (continued)**

| PAGE | ADD (dec) | ADD (hex) | Register Name               | Bit(s) | R/W | Default (bin) | Function             | Description                                                                 |
|------|-----------|-----------|-----------------------------|--------|-----|---------------|----------------------|-----------------------------------------------------------------------------|
| 0    | 22        | 16        | White Balance Configuration | [7:6]  | R/W | 0             | Page Setting         | 00: Configuration Registers<br>01: Red LUT<br>10: Green LUT<br>11: Blue LUT |
|      |           |           |                             | 5      | R/W | 0             | White Balance Enable | 0: WB disabled<br>1: WB enabled                                             |
|      |           |           |                             | 4      | R/W | 0             | Reload Enable        | 0: Reload disabled<br>1: Reload enabled                                     |
|      |           |           |                             | [3:0]  |     | 0             | <b>Reserved</b>      | <b>Reserved</b>                                                             |
| 1    | 0 - 255   | 00 - FF   | White Balance Red LUT       | [FF:0] | R/W | N/A           | Red LUT              | 256 8-bit entries to be applied to the Red subpixel data                    |
| 2    | 0 - 255   | 00 - FF   | White Balance Green LUT     | [FF:0] | R/W | N/A           | Green LUT            | 256 8-bit entries to be applied to the Green subpixel data                  |
| 3    | 0 - 255   | 00 - FF   | White Balance Blue LUT      | [FF:0] | R/W | N/A           | Blue LUT             | 256 8-bit entries to be applied to the Blue subpixel data                   |

## APPLICATIONS INFORMATION

### DISPLAY APPLICATION

The DS90UR905/916Q chipset is intended for interface between a host (graphics processor) and a Display. It supports an 24-bit color depth (RGB888) and up to 1024 X 768 display formats. In a RGB888 application, 24 color bits (R[7:0], G[7:0], B[7:0]), Pixel Clock (PCLK) and three control bits (VS, HS and DE) are supported across the serial link with PCLK rates from 5 to 65 MHz. The chipset may also be used in 18-bit color applications. In this application three to six general purpose signals may also be sent from host to display.

The Des is expected to be located close to its target device. The interconnect between the Des and the target device is typically in the 1 to 3 inch separation range. The input capacitance of the target device is expected to be in the 5 to 10 pF range. Care should be taken on the PCLK output trace as this signal is edge sensitive and strobes the data. It is also assumed that the fanout of the Des is one. If additional loads need to be driven, a logic buffer or mux device is recommended.

### TYPICAL APPLICATION CONNECTION

[Figure 31](#) shows a typical application of the DS90UR916Q Des using serial bus control mode for a 65 MHz 24-bit Color Display Application. The LVDS inputs utilize 100 nF coupling capacitors to the line and the Receiver provides internal termination. Bypass capacitors are placed near the power supply pins. At a minimum, seven 0.1  $\mu$ F capacitors and two 4.7  $\mu$ F capacitors should be used for local device bypassing. System GPO (General Purpose Output) signals control the PDB and the BISTEN pins. In this application the RRFB pin is tied Low to strobe the data on the falling edge of the PCLK.

The DS90UR916 will most often be used in serial bus control mode as this is required to enable the image enhancement features of the device. The schematic illustrates the proper connection of SDA and SCL to the pull-up resistors as well as the external resistor network to the ID[x] pin..

The interface to the target display is with 3.3V LVCMOS levels, thus the VDDIO pin is connected to the 3.3 V rail. A delay cap is placed on the PDB signal to delay the enabling of the device until power is stable.

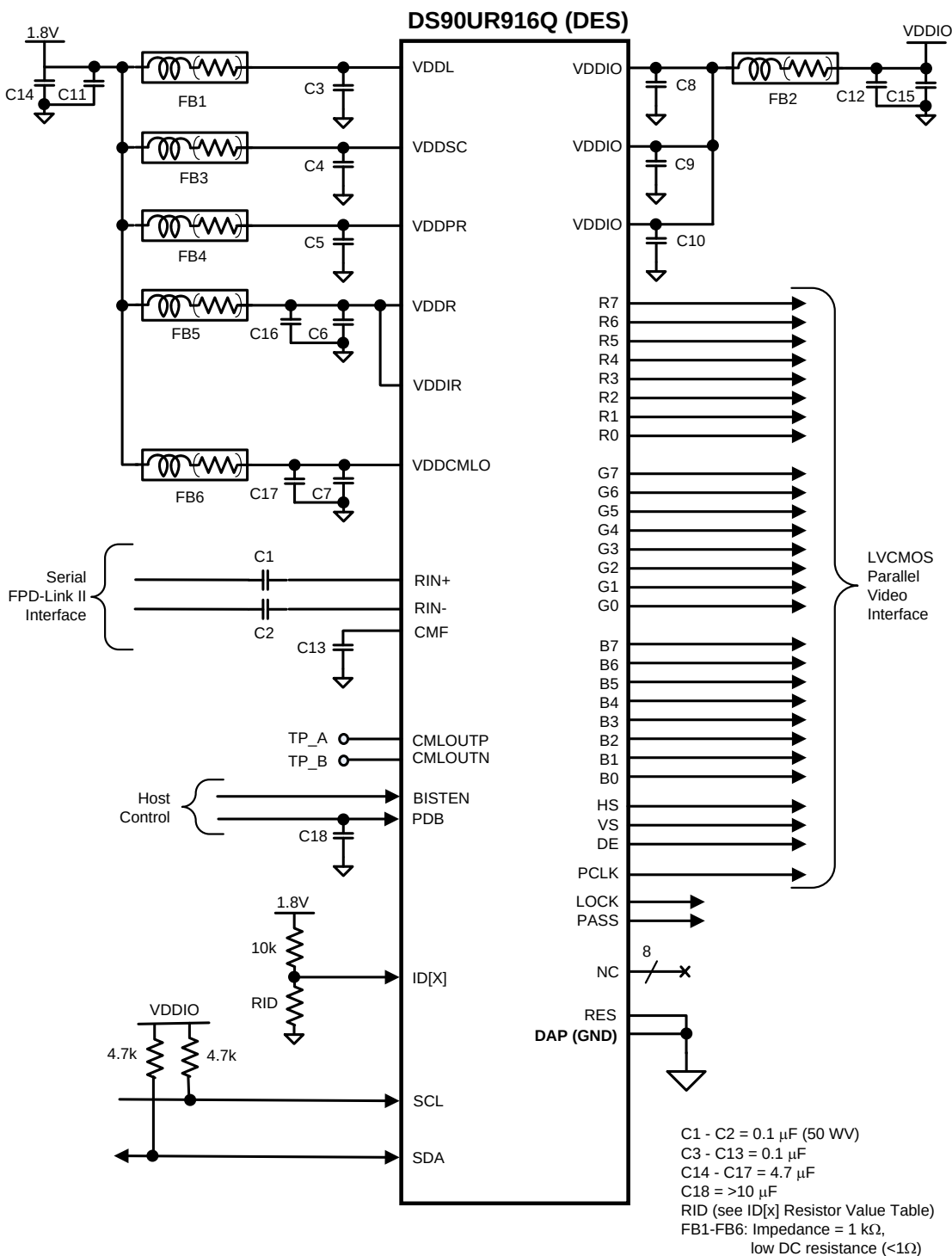


Figure 31. DS90UR916Q Typical Connection Diagram — Pin Control

## POWER UP REQUIREMENTS AND PDB PIN

At power-on, the PDB pin must be LOW. The transition to the HIGH state (normal operating mode) may only occur after all power supplies are stable and above the minimum recommended operating voltage. All other LVCMOS inputs must also remain LOW prior to power supplies stabilized at the recommended operating voltages. Active driving of inputs and the transition of PDB to the HIGH state should be delayed 1μsec after power supplies are stabilized.

## TRANSMISSION MEDIA

The Ser/Des chipset is intended to be used in a point-to-point configuration, through a PCB trace, or through twisted pair cable. The Ser and Des provide internal terminations providing a clean signaling environment. The interconnect for LVDS should present a differential impedance of 100 Ohms. Use cables and connectors that have matched differential impedance to minimize impedance discontinuities. Shielded or un-shielded cables may be used depending upon the noise environment and application requirements.

## LIVE LINK INSERTION

The Ser and Des devices support live pluggable applications. The automatic receiver lock to random data “plug & go” hot insertion capability allows the DS90UR916Q to attain lock to the active data stream during a live insertion event.

## PCB LAYOUT AND POWER SYSTEM CONSIDERATIONS

Circuit board layout and stack-up for the LVDS Ser/Des devices should be designed to provide low-noise power feed to the device. Good layout practice will also separate high frequency or high-level inputs and outputs to minimize unwanted stray noise pickup, feedback and interference. Power system performance may be greatly improved by using thin dielectrics (2 to 4 mils) for power / ground sandwiches. This arrangement provides plane capacitance for the PCB power system with low-inductance parasitics, which has proven especially effective at high frequencies, and makes the value and placement of external bypass capacitors less critical. External bypass capacitors should include both RF ceramic and tantalum electrolytic types. RF capacitors may use values in the range of 0.01 uF to 0.1 uF. Tantalum capacitors may be in the 2.2 uF to 10 uF range. Voltage rating of the tantalum capacitors should be at least 5X the power supply voltage being used.

Surface mount capacitors are recommended due to their smaller parasitics. When using multiple capacitors per supply pin, locate the smaller value closer to the pin. A large bulk capacitor is recommended at the point of power entry. This is typically in the 50uF to 100uF range and will smooth low frequency switching noise. It is recommended to connect power and ground pins directly to the power and ground planes with bypass capacitors connected to the plane with via on both ends of the capacitor. Connecting power or ground pins to an external bypass capacitor will increase the inductance of the path.

A small body size X7R chip capacitor, such as 0603, is recommended for external bypass. Its small body size reduces the parasitic inductance of the capacitor. The user must pay attention to the resonance frequency of these external bypass capacitors, usually in the range of 20-30 MHz. To provide effective bypassing, multiple capacitors are often used to achieve low impedance between the supply rails over the frequency of interest. At high frequency, it is also a common practice to use two vias from power and ground pins to the planes, reducing the impedance at high frequency.

Some devices provide separate power and ground pins for different portions of the circuit. This is done to isolate switching noise effects between different sections of the circuit. Separate planes on the PCB are typically not required. Pin Description tables typically provide guidance on which circuit blocks are connected to which power pin pairs. In some cases, an external filter may be used to provide clean power to sensitive circuits such as PLLs.

Use at least a four layer board with a power and ground plane. Locate LVCMOS signals away from the LVDS lines to prevent coupling from the LVCMOS lines to the LVDS lines. Closely-coupled differential lines of 100 Ohms are typically recommended for LVDS interconnect. The closely coupled lines help to ensure that coupled noise will appear as common-mode and thus is rejected by the receivers. The tightly coupled lines will also radiate less.

Information on the WQFN style package is provided in TI Application Note: AN-1187 ([SNOA401](#)).

## LVDS INTERCONNECT GUIDELINES

See AN-1108 ([SNLA008](#)) and AN-905 ([SNLA035](#)) for full details.

- Use 100Ω coupled differential pairs
- Use the S/2S/3S rule in spacings
  - S = space between the pair
  - 2S = space between pairs
  - 3S = space to LVCMOS signal
- Minimize the number of Vias
- Use differential connectors when operating above 500Mbps line speed
- Maintain balance of the traces
- Minimize skew within the pair
- Terminate as close to the TX outputs and RX inputs as possible

Additional general guidance can be found in the LVDS Owner's Manual - available in PDF format from the TI web site at: [www.ti.com/lvds](http://www.ti.com/lvds)

## USING IMAGE ENHANCEMENT FEATURES

The DS90UR916Q offers two FRC dithering blocks and one White Balance lookup table. Depending upon the color depth of the source data, display and LUT contents, these blocks may be independently enabled or disabled in various combinations. Refer to [Table 11](#) below for recommendations.

**Table 11. Enabling Image Enhancement Features**

| Source | White Balance LUT | Display | FRC1     | FRC2     |
|--------|-------------------|---------|----------|----------|
| 24-bit | 24-bit            | 24-bit  | Disabled | Disabled |
| 24-bit | 24-bit            | 18-bit  | Disabled | Enabled  |
| 24-bit | 18-bit            | 18-bit  | Enabled  | Disabled |
| 18-bit | 24-bit            | 24-bit  | Disabled | Disabled |
| 18-bit | 24-bit            | 18-bit  | Disabled | Enabled  |
| 18-bit | 18-bit            | 18-bit  | Disabled | Disabled |

If the white balance feature is to be used all 3 LUTs must be fully loaded after initial power-up. LUTs must be loaded sequentially — first Red, second Green, third Blue — and all 256 values must be loaded into each LUT. **After power-up the following procedure must be followed.**

1. Power-on (reload = disable by default)
2. Enable WB
3. Set page Register RED
4. Initial RED LUT load (all 256 bytes) *'916 will self clear page register*
5. Set page Register GREEN
6. Initial GREEN LUT load (all 256 bytes) *'916 will self clear page register*
7. Set page Register BLUE
8. Initial BLUE LUT load (all 256 bytes) *'916 will self clear page register*

Once all LUTs are loaded, '916 will enable the WB output

**To reload LUT contents, after the initial load at power-up, the following procedure must be followed.**

1. Enable RELOAD
2. Set appropriate page register (RED, GREEN or BLUE)
3. Load new LUT values (any sequence, any order, any number)
4. Load appropriate R, G or B 255 value to clear page register
5. Set appropriate page register (RED, GREEN or BLUE)
6. Load new LUT values (any sequence, any order, any number)
7. Load appropriate R, G or B 255 value to clear page register

8. Set appropriate page register (RED, GREEN or BLUE)
9. Load new LUT values (any sequence, any order, any number)
10. Load appropriate R, G or B 255 value to clear page register
11. Disable RELOAD

## ALTERNATE COLOR / DATA MAPPING

Color Mapped data Pin names are provided to specify a recommended mapping for 24-bit Color Applications. Seven [7] is assumed to be the MSB, and Zero [0] is assumed to be the LSB. While this is recommended it is not required. When connecting to earlier generations of FPD-Link II Ser and Des devices, a color mapping review is recommended to ensure the correct connectivity is obtained. [Table 12](#) provides examples for interfacing to 18-bit applications with or without the video control signals embedded. The DS90UR916Q Des also provides additional flexibility with the MAP\_SEL feature as well.

**Table 12. Alternate Color / Data Mapping — See Text Below**

| 18-bit RGB | 18-bit RGB | 18-bit RGB | 24-bit RGB | 905 Pin Name |  | 916 Pin Name | 24-bit RGB | 18-bit RGB | 18-bit RGB | 18-bit RGB |
|------------|------------|------------|------------|--------------|--|--------------|------------|------------|------------|------------|
| 0          | LSB R0     | GP0        | RO         | RO           |  | R0           | R0         | GP0        | LSB R0     | 0          |
| 0          | R1         | GP1        | R1         | R1           |  | R1           | R1         | GP1        | R1         | 0          |
| R0         | R2         | R0         | R2         | R2           |  | R2           | R2         | R0         | R2         | R0         |
| R1         | R3         | R1         | R3         | R3           |  | R3           | R3         | R1         | R3         | R1         |
| R2         | R4         | R2         | R4         | R4           |  | R4           | R4         | R2         | R4         | R2         |
| R3         | MSB R5     | R3         | R5         | R5           |  | R5           | R5         | R3         | MSB R5     | R3         |
| R4         | LSB G0     | R4         | R6         | R6           |  | R6           | R6         | R4         | LSB G0     | R4         |
| R5         | G1         | R5         | R7         | R7           |  | R7           | R7         | R5         | G1         | R5         |
| 0          | G2         | GP2        | G0         | G0           |  | G0           | G0         | GP2        | G2         | 0          |
| 0          | G3         | GP3        | G1         | G1           |  | G1           | G1         | GP3        | G3         | 0          |
| G0         | G4         | G0         | G2         | G2           |  | G2           | G2         | G0         | G4         | G0         |
| G1         | MSB G5     | G1         | G3         | G3           |  | G3           | G3         | G1         | MSB G5     | G1         |
| G2         | LSB B0     | G2         | G4         | G4           |  | G4           | G4         | G2         | LSB B0     | G2         |
| G3         | B1         | G3         | G5         | G5           |  | G5           | G5         | G3         | B1         | G3         |
| G4         | B2         | G4         | G6         | G6           |  | G6           | G6         | G4         | B2         | G4         |
| G5         | B3         | G5         | G7         | G7           |  | G7           | G7         | G5         | B3         | G5         |
| 0          | B4         | GP4        | B0         | B0           |  | B0           | B0         | GP4        | B4         | 0          |
| 0          | MSB B5     | GP5        | B1         | B1           |  | B1           | B1         | GP5        | MSB B5     | 0          |
| B0         | HS         | B0         | B2         | B2           |  | B2           | B2         | B0         | HS         | B0         |
| B1         | VS         | B1         | B3         | B3           |  | B3           | B3         | B1         | VS         | B1         |
| B2         | DE         | B2         | B4         | B4           |  | B4           | B4         | B2         | DE         | B2         |
| B3         | GP0        | B3         | B5         | B5           |  | B5           | B5         | B3         | GP0        | B3         |
| B4         | GP1        | B4         | B6         | B6           |  | B6           | B6         | B4         | GP1        | B4         |
| B5         | GP2        | B5         | B7         | B7           |  | B7           | B7         | B5         | GP2        | B5         |
| HS         | GND        | HS         | HS         | HS           |  | HS           | HS         | HS         | GND        | HS         |
| VS         | GND        | VS         | VS         | VS           |  | VS           | VS         | VS         | GND        | VS         |
| DE         | GND        | DE         | DE         | DE           |  | DE           | DE         | DE         | GND        |            |
| Scenario 4 | Scenario 3 | Scenario 2 | Scenario 1 | 905 Pin Name |  | 916 Pin Name | Scenario 1 | Scenario 2 | Scenario 3 | Scenario 4 |

**Scenario 4**

Scenario 4 supports an 18-bit RGB color mapping and 3 embedded video control signals. All LSBs are set to “0”. FRC and white balance may be enabled with this scenario.

**Scenario 3**

Scenario 3 supports an 18-bit RGB color mapping, 3 un-embedded video control signals, and up to three general purpose signals. This scenario is NOT supported when FRC or white balance are enabled on the DS90UR916.

**Scenario 2**

Scenario 2 supports an 18-bit RGB color mapping, 3 embedded video control signals, and up to six general purpose signals. This scenario is NOT supported when FRC or white balance are enabled on the DS90UR916.

**Scenario 1**

Scenario 1 supports the 24-bit RGB color mapping, along with the 3 embedded video control signals. This is the native mode for the chipset. FRC and white balance may be enabled with this scenario.

REVISION HISTORY

| Changes from Revision D (April 2013) to Revision E         | Page               |
|------------------------------------------------------------|--------------------|
| • Changed layout of National Data Sheet to TI format ..... | <a href="#">39</a> |

## PACKAGING INFORMATION

| Orderable Device   | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish | MSL Peak Temp<br>(3) | Op Temp (°C) | Top-Side Markings<br>(4) | Samples                 |
|--------------------|---------------|--------------|--------------------|------|----------------|----------------------------|------------------|----------------------|--------------|--------------------------|-------------------------|
| DS90UR916QSQ/NOPB  | ACTIVE        | WQFN         | NKB                | 60   | 1000           | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-3-260C-168 HR  | -40 to 105   | UR916QSQ                 | <a href="#">Samples</a> |
| DS90UR916QSQE/NOPB | ACTIVE        | WQFN         | NKB                | 60   | 250            | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-3-260C-168 HR  | -40 to 105   | UR916QSQ                 | <a href="#">Samples</a> |
| DS90UR916QSQX/NOPB | ACTIVE        | WQFN         | NKB                | 60   | 2000           | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-3-260C-168 HR  | -40 to 105   | UR916QSQ                 | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

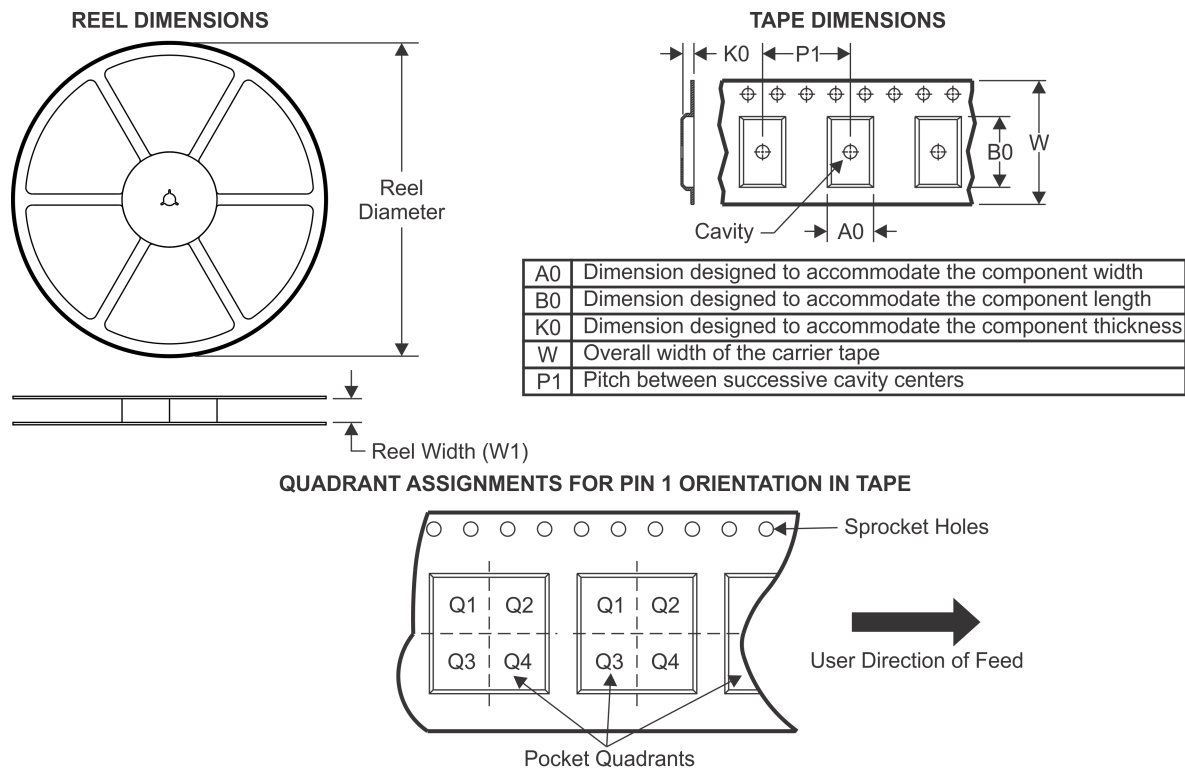
**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Multiple Top-Side Markings will be inside parentheses. Only one Top-Side Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Top-Side Marking for that device.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

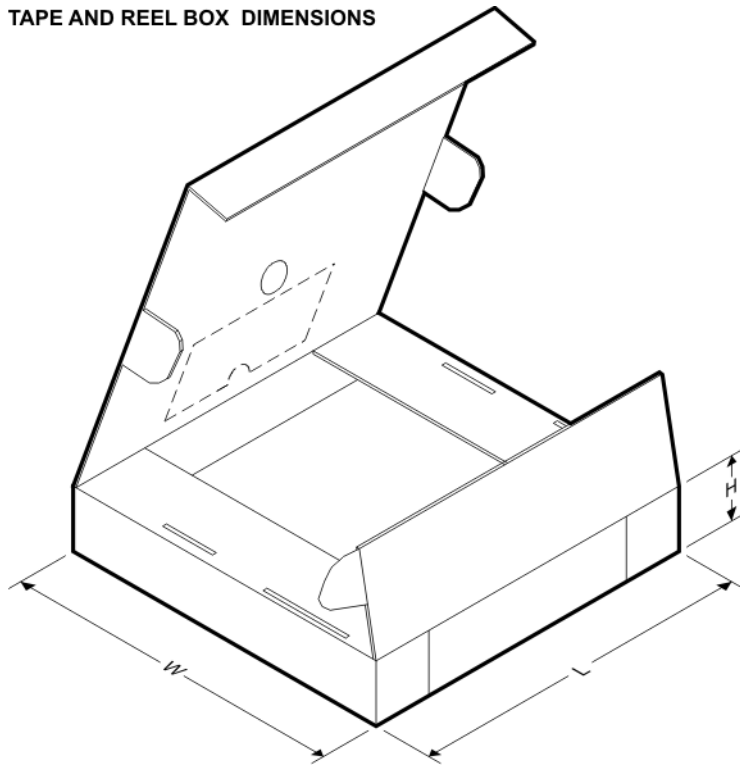
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

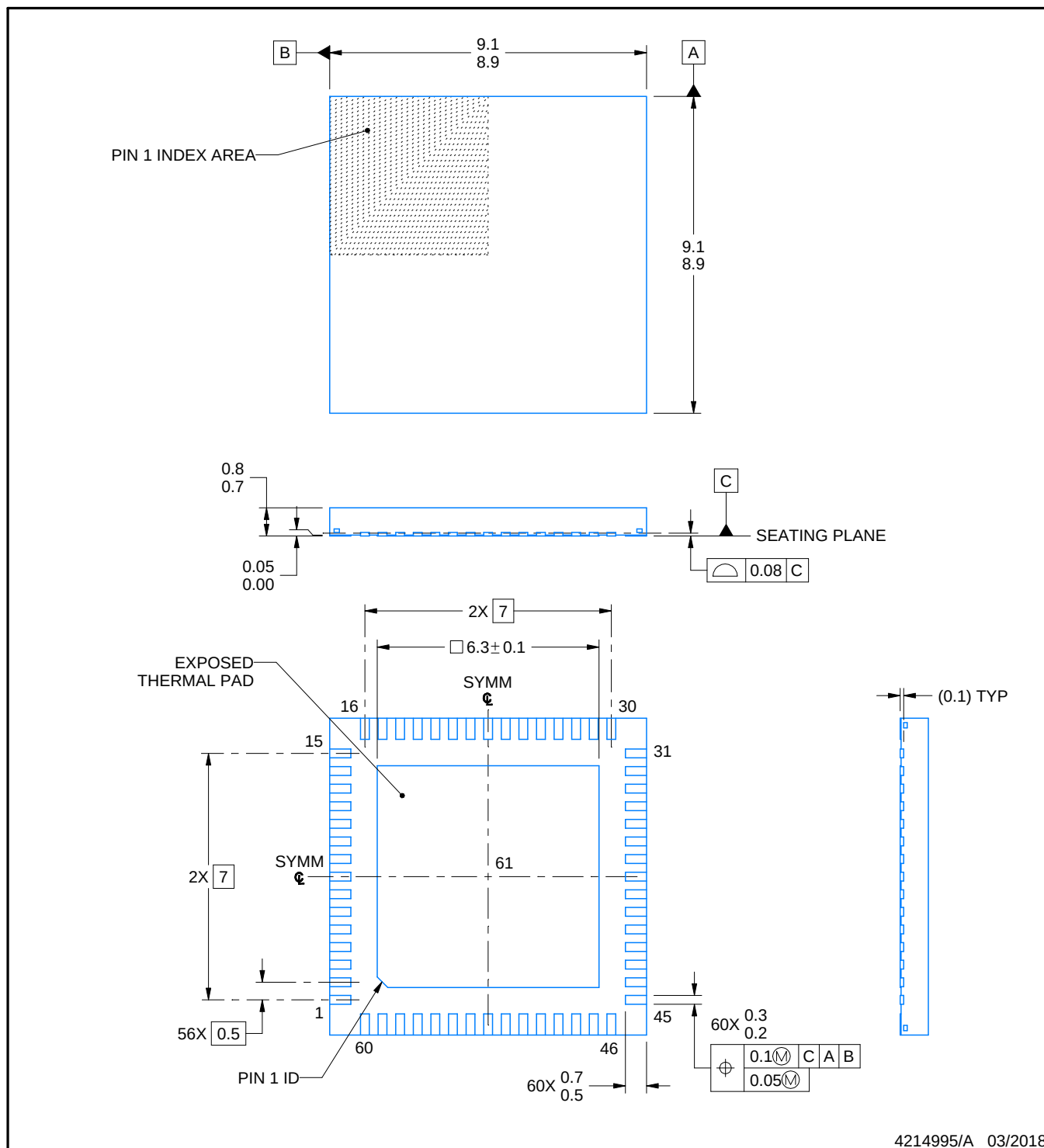
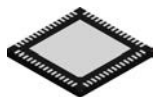
| Device             | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| DS90UR916QSQ/NOPB  | WQFN         | NKB             | 60   | 1000 | 330.0              | 16.4               | 9.3     | 9.3     | 1.3     | 12.0    | 16.0   | Q1            |
| DS90UR916QSQE/NOPB | WQFN         | NKB             | 60   | 250  | 178.0              | 16.4               | 9.3     | 9.3     | 1.3     | 12.0    | 16.0   | Q1            |
| DS90UR916QSQX/NOPB | WQFN         | NKB             | 60   | 2000 | 330.0              | 16.4               | 9.3     | 9.3     | 1.3     | 12.0    | 16.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device             | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| DS90UR916QSQ/NOPB  | WQFN         | NKB             | 60   | 1000 | 367.0       | 367.0      | 38.0        |
| DS90UR916QSQE/NOPB | WQFN         | NKB             | 60   | 250  | 210.0       | 185.0      | 35.0        |
| DS90UR916QSQX/NOPB | WQFN         | NKB             | 60   | 2000 | 367.0       | 367.0      | 38.0        |



NOTES:

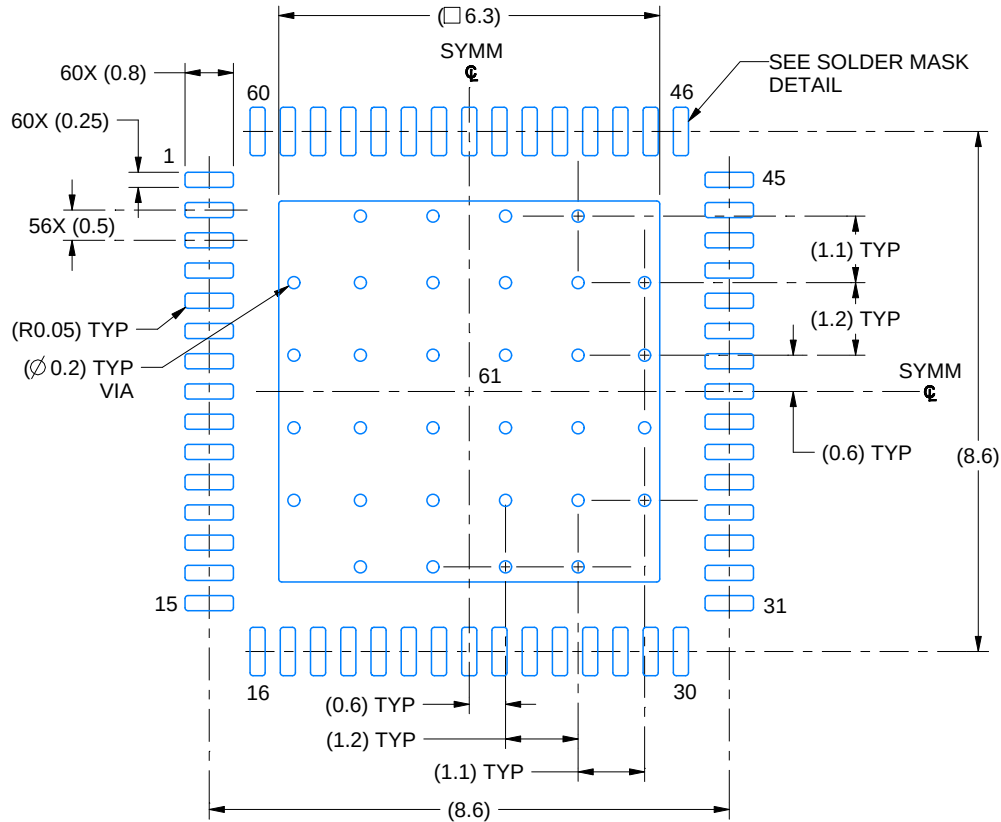
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

# EXAMPLE BOARD LAYOUT

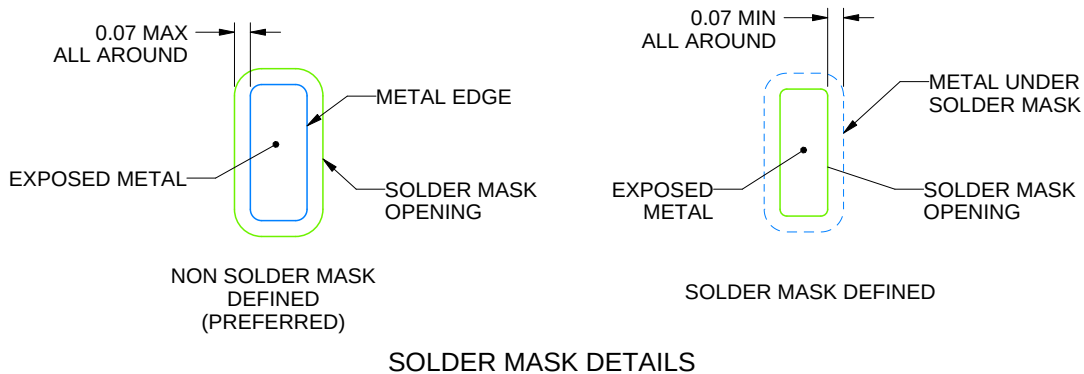
NKB0060B

VQFN - 0.8 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 8X



4214995/A 03/2018

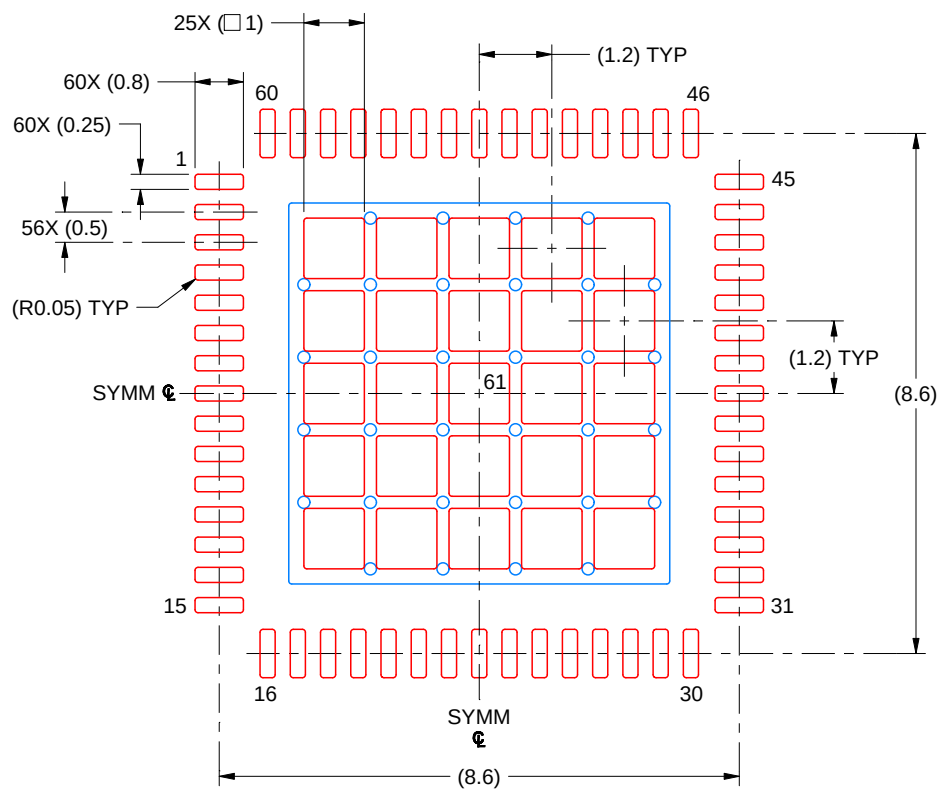
NOTES: (continued)

- This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/sluea271](http://www.ti.com/lit/sluea271)).
- Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

**NKB0060B**

### VQFN - 0.8 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



SOLDER PASTE EXAMPLE  
BASED ON 0.125 MM THICK STENCIL  
SCALE: 8X

EXPOSED PAD 61  
63% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE

4214995/A 03/2018

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

## IMPORTANT NOTICE

Texas Instruments Incorporated (TI) reserves the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete.

TI's published terms of sale for semiconductor products (<http://www.ti.com/sc/docs/stdterms.htm>) apply to the sale of packaged integrated circuit products that TI has qualified and released to market. Additional terms may apply to the use or sale of other types of TI products and services.

Reproduction of significant portions of TI information in TI data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such reproduced documentation. Information of third parties may be subject to additional restrictions. Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyers and others who are developing systems that incorporate TI products (collectively, "Designers") understand and agree that Designers remain responsible for using their independent analysis, evaluation and judgment in designing their applications and that Designers have full and exclusive responsibility to assure the safety of Designers' applications and compliance of their applications (and of all TI products used in or for Designers' applications) with all applicable regulations, laws and other applicable requirements. Designer represents that, with respect to their applications, Designer has all the necessary expertise to create and implement safeguards that (1) anticipate dangerous consequences of failures, (2) monitor failures and their consequences, and (3) lessen the likelihood of failures that might cause harm and take appropriate actions. Designer agrees that prior to using or distributing any applications that include TI products, Designer will thoroughly test such applications and the functionality of such TI products as used in such applications.

TI's provision of technical, application or other design advice, quality characterization, reliability data or other services or information, including, but not limited to, reference designs and materials relating to evaluation modules, (collectively, "TI Resources") are intended to assist designers who are developing applications that incorporate TI products; by downloading, accessing or using TI Resources in any way, Designer (individually or, if Designer is acting on behalf of a company, Designer's company) agrees to use any particular TI Resource solely for this purpose and subject to the terms of this Notice.

TI's provision of TI Resources does not expand or otherwise alter TI's applicable published warranties or warranty disclaimers for TI products, and no additional obligations or liabilities arise from TI providing such TI Resources. TI reserves the right to make corrections, enhancements, improvements and other changes to its TI Resources. TI has not conducted any testing other than that specifically described in the published documentation for a particular TI Resource.

Designer is authorized to use, copy and modify any individual TI Resource only in connection with the development of applications that include the TI product(s) identified in such TI Resource. NO OTHER LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE TO ANY OTHER TI INTELLECTUAL PROPERTY RIGHT, AND NO LICENSE TO ANY TECHNOLOGY OR INTELLECTUAL PROPERTY RIGHT OF TI OR ANY THIRD PARTY IS GRANTED HEREIN, including but not limited to any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information regarding or referencing third-party products or services does not constitute a license to use such products or services, or a warranty or endorsement thereof. Use of TI Resources may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

TI RESOURCES ARE PROVIDED "AS IS" AND WITH ALL FAULTS. TI DISCLAIMS ALL OTHER WARRANTIES OR REPRESENTATIONS, EXPRESS OR IMPLIED, REGARDING RESOURCES OR USE THEREOF, INCLUDING BUT NOT LIMITED TO ACCURACY OR COMPLETENESS, TITLE, ANY EPIDEMIC FAILURE WARRANTY AND ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, AND NON-INFRINGEMENT OF ANY THIRD PARTY INTELLECTUAL PROPERTY RIGHTS. TI SHALL NOT BE LIABLE FOR AND SHALL NOT DEFEND OR INDEMNIFY DESIGNER AGAINST ANY CLAIM, INCLUDING BUT NOT LIMITED TO ANY INFRINGEMENT CLAIM THAT RELATES TO OR IS BASED ON ANY COMBINATION OF PRODUCTS EVEN IF DESCRIBED IN TI RESOURCES OR OTHERWISE. IN NO EVENT SHALL TI BE LIABLE FOR ANY ACTUAL, DIRECT, SPECIAL, COLLATERAL, INDIRECT, PUNITIVE, INCIDENTAL, CONSEQUENTIAL OR EXEMPLARY DAMAGES IN CONNECTION WITH OR ARISING OUT OF TI RESOURCES OR USE THEREOF, AND REGARDLESS OF WHETHER TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES.

Unless TI has explicitly designated an individual product as meeting the requirements of a particular industry standard (e.g., ISO/TS 16949 and ISO 26262), TI is not responsible for any failure to meet such industry standard requirements.

Where TI specifically promotes products as facilitating functional safety or as compliant with industry functional safety standards, such products are intended to help enable customers to design and create their own applications that meet applicable functional safety standards and requirements. Using products in an application does not by itself establish any safety features in the application. Designers must ensure compliance with safety-related requirements and standards applicable to their applications. Designer may not use any TI products in life-critical medical equipment unless authorized officers of the parties have executed a special contract specifically governing such use. Life-critical medical equipment is medical equipment where failure of such equipment would cause serious bodily injury or death (e.g., life support, pacemakers, defibrillators, heart pumps, neurostimulators, and implantables). Such equipment includes, without limitation, all medical devices identified by the U.S. Food and Drug Administration as Class III devices and equivalent classifications outside the U.S.

TI may expressly designate certain products as completing a particular qualification (e.g., Q100, Military Grade, or Enhanced Product). Designers agree that it has the necessary expertise to select the product with the appropriate qualification designation for their applications and that proper product selection is at Designers' own risk. Designers are solely responsible for compliance with all legal and regulatory requirements in connection with such selection.

Designer will fully indemnify TI and its representatives against any damages, costs, losses, and/or liabilities arising out of Designer's non-compliance with the terms and provisions of this Notice.

## Looking for pricing, stock, or lifecycle information?

Click below to explore more details on WIN SOURCE:

- ⊖ View [DS90UR916QSQX/NOPB](#) on WIN SOURCE
- ⊖ [Texas Instruments](#) Information

## Optimize Your Supply Chain with WIN SOURCE Solutions

- ✓ Global Sourcing Solution
- ✓ Obsolete Management
- ✓ Cost Control Management
- ✓ Shortage Management
- ✓ Alternative Solution
- ✓ Excess Inventory Management